



**128K x 36, 256K x 18**  
**3.3V Synchronous ZBT™ SRAMs**  
**2.5V I/O, Burst Counter**  
**Pipelined Outputs**

**IDT71V2556**  
**IDT71V2558**

## Features

- ◆ 128K x 36, 256K x 18 memory configurations
- ◆ Supports high performance system speed - 200 MHz (3.2 ns Clock-to-Data Access)
- ◆ ZBT™ Feature - No dead cycles between write and read cycles
- ◆ Internally synchronized output buffer enable eliminates the need to control  $\overline{OE}$
- ◆ Single  $R/\overline{W}$  (READ/WRITE) control pin
- ◆ Positive clock-edge triggered address, data, and control signal registers for fully pipelined applications
- ◆ 4-word burst capability (interleaved or linear)
- ◆ Individual byte write ( $\overline{BW}_1$  -  $\overline{BW}_4$ ) control (May tie active)
- ◆ Three chip enables for simple depth expansion
- ◆ 3.3V power supply ( $\pm 5\%$ )
- ◆ 2.5V I/O Supply ( $V_{DDQ}$ )
- ◆ Packaged in a JEDEC standard 100-pin plastic thin quad flatpack (TQFP), 119 ball grid array (BGA) and 165 fine pitch ball grid array (fBGA)

## Description

The IDT71V2556/58 are 3.3V high-speed 4,718,592-bit (4.5 Mega-bit) synchronous SRAMs. They are designed to eliminate dead bus cycles when turning the bus around between reads and writes, or writes and reads. Thus, they have been given the name ZBT™, or Zero Bus Turnaround.

Address and control signals are applied to the SRAM during one clock

cycle, and two cycles later the associated data cycle occurs, be it read or write.

The IDT71V2556/58 contain data I/O, address and control signal registers. Output enable is the only asynchronous signal and can be used to disable the outputs at any given time.

A Clock Enable ( $\overline{CEN}$ ) pin allows operation of the IDT71V2556/58 to be suspended as long as necessary. All synchronous inputs are ignored when ( $\overline{CEN}$ ) is high and the internal device registers will hold their previous values.

There are three chip enable pins ( $\overline{CE}_1$ ,  $CE_2$ ,  $\overline{CE}_2$ ) that allow the user to deselect the device when desired. If any one of these three are not asserted when  $ADV/\overline{LD}$  is low, no new memory operation can be initiated. However, any pending data transfers (reads or writes) will be completed. The data bus will tri-state two cycles after chip is deselected or a write is initiated.

The IDT71V2556/58 has an on-chip burst counter. In the burst mode, the IDT71V2556/58 can provide four cycles of data for a single address presented to the SRAM. The order of the burst sequence is defined by the  $\overline{LBO}$  input pin. The  $\overline{LBO}$  pin selects between linear and interleaved burst sequence. The  $ADV/\overline{LD}$  signal is used to load a new external address ( $ADV/\overline{LD} = \text{LOW}$ ) or increment the internal burst counter ( $ADV/\overline{LD} = \text{HIGH}$ ).

The IDT71V2556/58 SRAMs utilize IDT's latest high-performance CMOS process and are packaged in a JEDEC standard 14mm x 20mm 100-pin thin plastic quad flatpack (TQFP) as well as a 119 ball grid array (BGA) and a 165 fine pitch ball grid array (fBGA).

## Pin Description Summary

|                                                                               |                                          |        |              |
|-------------------------------------------------------------------------------|------------------------------------------|--------|--------------|
| A0-A17                                                                        | Address Inputs                           | Input  | Synchronous  |
| $\overline{CE}_1$ , $CE_2$ , $\overline{CE}_2$                                | Chip Enables                             | Input  | Synchronous  |
| $\overline{OE}$                                                               | Output Enable                            | Input  | Asynchronous |
| $R/\overline{W}$                                                              | Read/Write Signal                        | Input  | Synchronous  |
| $\overline{CEN}$                                                              | Clock Enable                             | Input  | Synchronous  |
| $\overline{BW}_1$ , $\overline{BW}_2$ , $\overline{BW}_3$ , $\overline{BW}_4$ | Individual Byte Write Selects            | Input  | Synchronous  |
| CLK                                                                           | Clock                                    | Input  | N/A          |
| $ADV/\overline{LD}$                                                           | Advance burst address / Load new address | Input  | Synchronous  |
| $\overline{LBO}$                                                              | Linear / Interleaved Burst Order         | Input  | Static       |
| I/O0-I/O31, I/O P1-I/O P4                                                     | Data Input / Output                      | I/O    | Synchronous  |
| $V_{DD}$ , $V_{DDQ}$                                                          | Core Power, I/O Power                    | Supply | Static       |
| $V_{SS}$                                                                      | Ground                                   | Supply | Static       |

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## Pin Definitions<sup>(1)</sup>

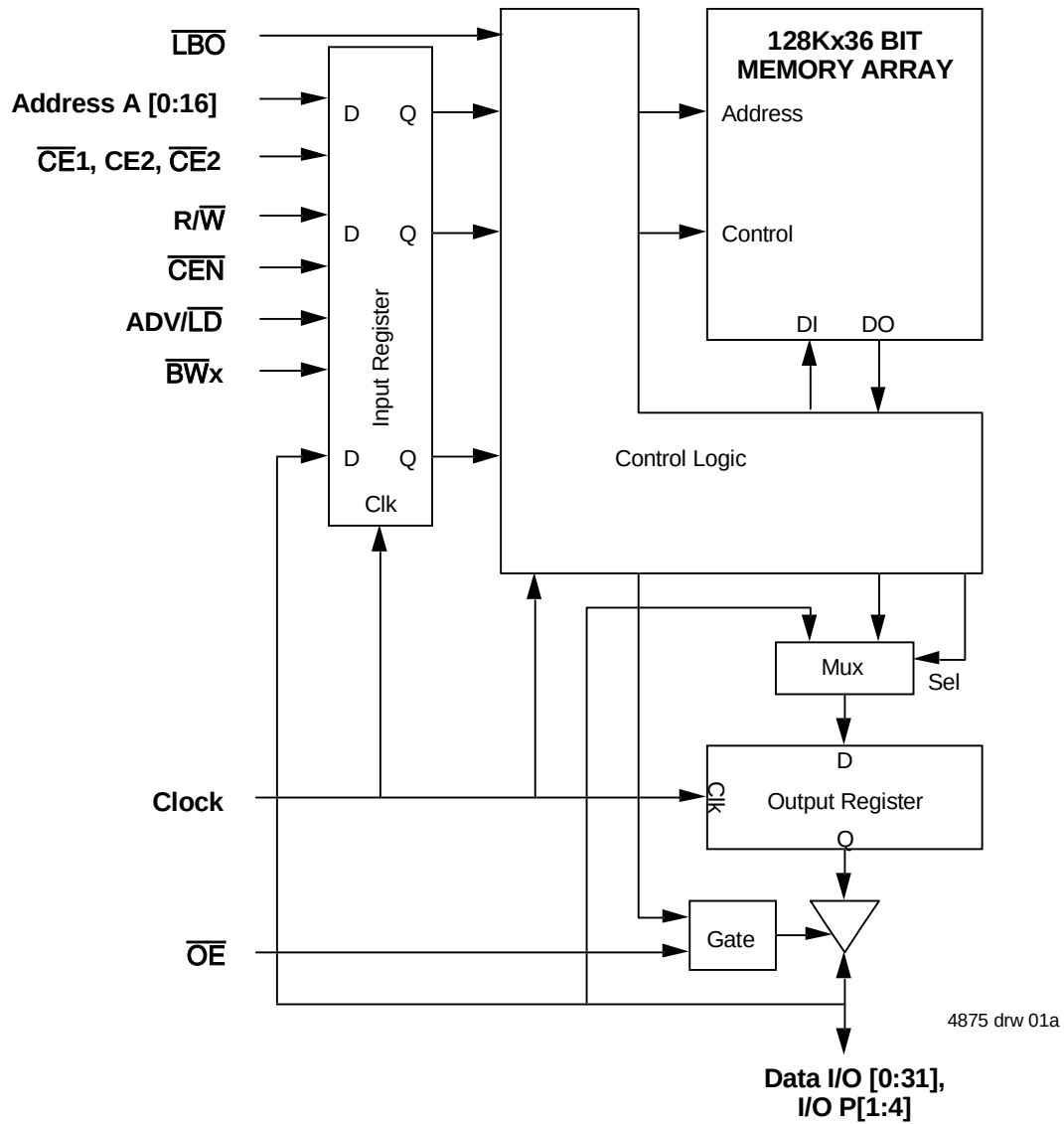
| Symbol                    | Pin Function                  | I/O | Active | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
|---------------------------|-------------------------------|-----|--------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A0-A17                    | Address Inputs                | I   | N/A    | Synchronous Address inputs. The address register is triggered by a combination of the rising edge of CLK, ADV/LD low, CEN low, and true chip enables.                                                                                                                                                                                                                                                                                                                                                        |
| ADV/LD                    | Advance / Load                | I   | N/A    | ADV/LD is a synchronous input that is used to load the internal registers with new address and control when it is sampled low at the rising edge of clock with the chip selected. When ADV/LD is low with the chip deselected, any burst in progress is terminated. When ADV/LD is sampled high then the internal burst counter is advanced for any burst that was in progress. The external addresses are ignored when ADV/LD is sampled high.                                                              |
| R/W                       | Read / Write                  | I   | N/A    | R/W signal is a synchronous input that identifies whether the current load cycle initiated is a Read or Write access to the memory array. The data bus activity for the current cycle takes place two clock cycles later.                                                                                                                                                                                                                                                                                    |
| CEN                       | Clock Enable                  | I   | LOW    | Synchronous Clock Enable Input. When CEN is sampled high, all other synchronous inputs, including clock are ignored and outputs remain unchanged. The effect of CEN sampled high on the device outputs is as if the low to high clock transition did not occur. For normal operation, CEN must be sampled low at rising edge of clock.                                                                                                                                                                       |
| BW1-BW4                   | Individual Byte Write Enables | I   | LOW    | Synchronous byte write enables. Each 9-bit byte has its own active low byte write enable. On load write cycles (When R/W and ADV/LD are sampled low) the appropriate byte write signal (BW1-BW4) must be valid. The byte write signal must also be valid on each cycle of a burst write. Byte Write signals are ignored when R/W is sampled high. The appropriate byte(s) of data are written into the device two cycles later. BW1-BW4 can all be tied low if always doing write to the entire 36-bit word. |
| CE1, CE2                  | Chip Enables                  | I   | LOW    | Synchronous active low chip enable. CE1 and CE2 are used with CE2 to enable the IDT71V2556/58. (CE1 or CE2 sampled high or CE2 sampled low) and ADV/LD low at the rising edge of clock, initiates a deselect cycle. The ZBT™ has a two cycle deselect, i.e., the data bus will tri-state two clock cycles after deselect is initiated.                                                                                                                                                                       |
| CE2                       | Chip Enable                   | I   | HIGH   | Synchronous active high chip enable. CE2 is used with CE1 and CE2 to enable the chip. CE2 has inverted polarity but otherwise identical to CE1 and CE2.                                                                                                                                                                                                                                                                                                                                                      |
| CLK                       | Clock                         | I   | N/A    | This is the clock input to the IDT71V2556/58. Except for OE, all timing references for the device are made with respect to the rising edge of CLK.                                                                                                                                                                                                                                                                                                                                                           |
| I/O0-I/O31<br>I/OP1-I/OP4 | Data Input/Output             | I/O | N/A    | Synchronous data input/output (I/O) pins. Both the data input path and data output path are registered and triggered by the rising edge of CLK.                                                                                                                                                                                                                                                                                                                                                              |
| LBO                       | Linear Burst Order            | I   | LOW    | Burst order selection input. When LBO is high the Interleaved burst sequence is selected. When LBO is low the Linear burst sequence is selected. LBO is a static input and it must not change during device operation.                                                                                                                                                                                                                                                                                       |
| OE                        | Output Enable                 | I   | LOW    | Asynchronous output enable. OE must be low to read data from the 71V2556/58. When OE is high the I/O pins are in a high-impedance state. OE does not need to be actively controlled for read and write cycles. In normal operation, OE can be tied low.                                                                                                                                                                                                                                                      |
| VDD                       | Power Supply                  | N/A | N/A    | 3.3V core power supply.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| VDDQ                      | Power Supply                  | N/A | N/A    | 2.5V I/O Supply.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| VSS                       | Ground                        | N/A | N/A    | Ground.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |

### NOTE:

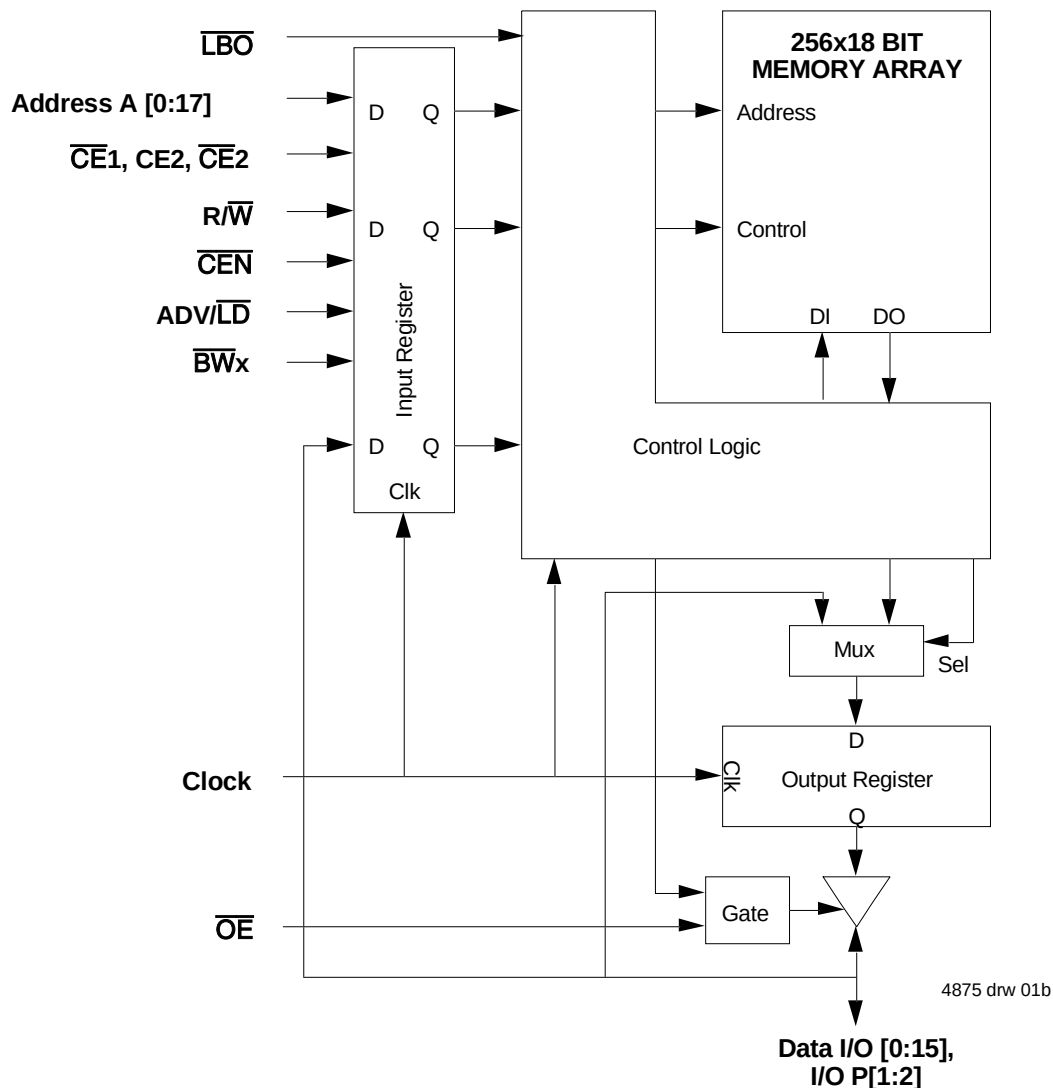
1. All synchronous inputs must meet specified setup and hold times with respect to CLK.

4875 tbl 02

## Functional Block Diagram



## Functional Block Diagram



## Recommended DC Operating Conditions

| Symbol           | Parameter                   | Min.                | Typ. | Max.                                  | Unit |
|------------------|-----------------------------|---------------------|------|---------------------------------------|------|
| V <sub>DD</sub>  | Core Supply Voltage         | 3.135               | 3.3  | 3.465                                 | V    |
| V <sub>DDQ</sub> | I/O Supply Voltage          | 2.375               | 2.5  | 2.625                                 | V    |
| V <sub>SS</sub>  | Supply Voltage              | 0                   | 0    | 0                                     | V    |
| V <sub>IH</sub>  | Input High Voltage - Inputs | 1.7                 | —    | V <sub>DD</sub> + 0.3                 | V    |
| V <sub>IH</sub>  | Input High Voltage - I/O    | 1.7                 | —    | V <sub>DDQ</sub> + 0.3 <sup>(2)</sup> | V    |
| V <sub>IL</sub>  | Input Low Voltage           | -0.3 <sup>(1)</sup> | —    | 0.7                                   | V    |

### NOTES:

- V<sub>IL</sub> (min.) = -1.0V for pulse width less than tc<sub>yc</sub>/2, once per cycle.
- V<sub>IH</sub> (max.) = +6.0V for pulse width less than tc<sub>yc</sub>/2, once per cycle.

## Recommended Operating Temperature and Supply Voltage

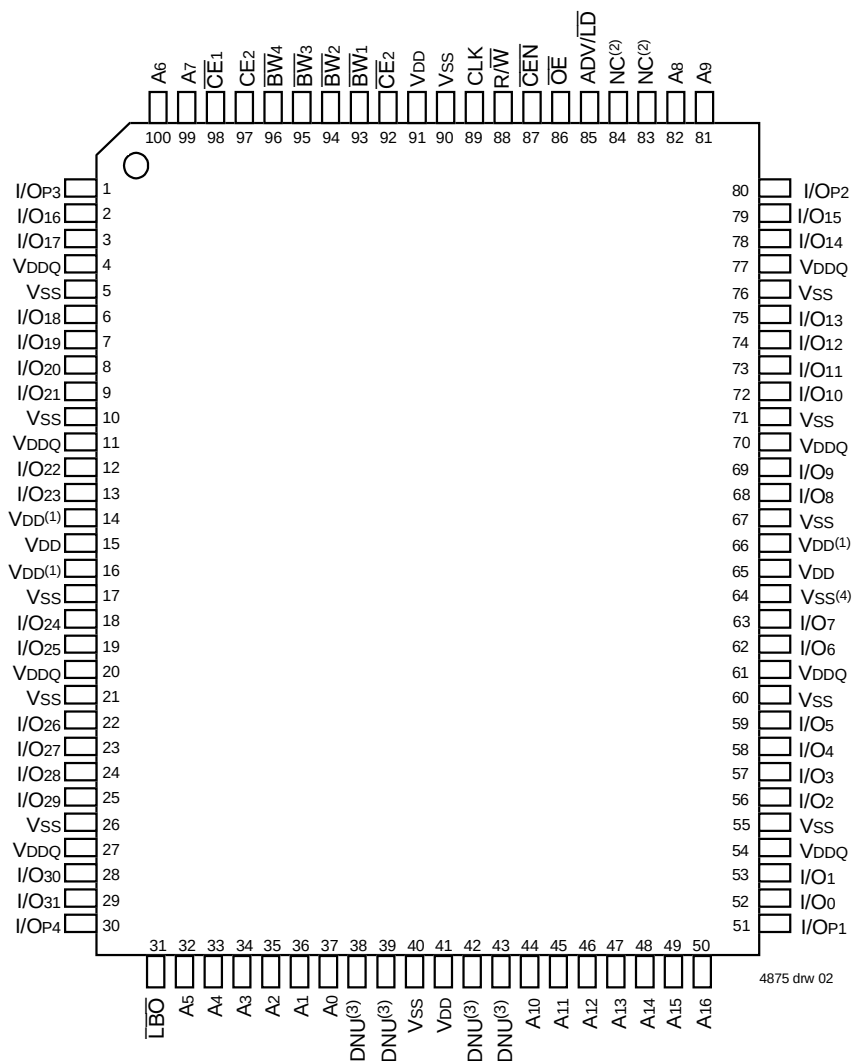
| Grade      | Temperature <sup>(1)</sup> | V <sub>SS</sub> | V <sub>DD</sub> | V <sub>DDQ</sub> |
|------------|----------------------------|-----------------|-----------------|------------------|
| Commercial | 0°C to +70°C               | 0V              | 3.3V±5%         | 2.5V±5%          |
| Industrial | -40°C to +85°C             | 0V              | 3.3V±5%         | 2.5V±5%          |

### NOTES:

4875 tbl 05

1. T<sub>A</sub> is the "instant on" case temperature.

## Pin Configuration — 128K x 36



4875 drw 02

## Top View TQFP

### NOTES:

1. Pins 14, 16 and 66 do not have to be connected directly to V<sub>DD</sub> as long as the input voltage is ≥ V<sub>IH</sub>.
2. Pins 83 and 84 are reserved for future 8M and 16M respectively.
3. DNU = Do not use; Pins 38, 39, 42, and 43 are reserved for respective JTAG pins: TMS, TDI, TDO, and TCK on future revisions. Within this current version, these pins are not connected.
4. Pin 64 does not have to be connected directly to V<sub>SS</sub> as long as the input voltage is ≤ V<sub>IL</sub>. On future revisions Pin 64 will be used for ZZ (sleep mode).

### Absolute Maximum Ratings<sup>(1)</sup>



1. Pins 14, 16 and 66 do not have to be connected directly to VDD as long as the input voltage is  $\geq V_{IH}$ .
2. Pins 83 and 84 are reserved for future 8M and 16M respectively.
3. DNU = Do not use; Pins 38, 39, 42, and 43 are reserved for respective JTAG pins: TMS, TDI, TDO, and TCK on future revisions. Within this current version, these pins are not connected.
4. Pin 64 does not have to be connected directly to VSS as long as the input voltage is  $\leq V_{IL}$ . On future revisions Pin 64 will be used for ZZ (sleep mode).

| Symbol          | Parameter <sup>(1)</sup> | Conditions             | Max. | Unit |
|-----------------|--------------------------|------------------------|------|------|
| C <sub>IN</sub> | Input Capacitance        | V <sub>IN</sub> = 3dV  | 5    | pF   |
| C <sub>IO</sub> | I/O Capacitance          | V <sub>OUT</sub> = 3dV | 7    | pF   |

4875 thl 07

| Symbol           | Parameter <sup>(1)</sup> | Conditions             | Max. | Unit |
|------------------|--------------------------|------------------------|------|------|
| C <sub>IN</sub>  | Input Capacitance        | V <sub>IN</sub> = 3dV  | TBD  | pF   |
| C <sub>I/O</sub> | I/O Capacitance          | V <sub>OUT</sub> = 3dV | TBD  | pF   |

4875 th | 07h

1. This parameter is guaranteed by device characterization, but not production tested.

| Symbol                             | Rating                               | Commercial & Industrial Values | Unit |
|------------------------------------|--------------------------------------|--------------------------------|------|
| V <sub>TERM</sub> <sup>(2)</sup>   | Terminal Voltage with Respect to GND | -0.5 to +4.6                   | V    |
| V <sub>TERM</sub> <sup>(3,6)</sup> | Terminal Voltage with Respect to GND | -0.5 to V <sub>DD</sub>        | V    |
| V <sub>TERM</sub> <sup>(4,6)</sup> | Terminal Voltage with Respect to GND | -0.5 to V <sub>DD</sub> +0.5   | V    |
| V <sub>TERM</sub> <sup>(5,6)</sup> | Terminal Voltage with Respect to GND | -0.5 to V <sub>DDQ</sub> +0.5  | V    |
| T <sub>A</sub> <sup>(7)</sup>      | Commerical Operating Temperature     | -0 to +70                      | °C   |
|                                    | Industrial Operating Temperature     | -40 to +85                     | °C   |
| T <sub>BIAS</sub>                  | Temperature Under Bias               | -55 to +125                    | °C   |
| T <sub>STG</sub>                   | Storage Temperature                  | -55 to +125                    | °C   |
| P <sub>T</sub>                     | Power Dissipation                    | 2.0                            | W    |
| I <sub>OUT</sub>                   | DC Output Current                    | 50                             | mA   |

4875 tbi 06

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
2.  $V_{DD}$  terminals only.
3.  $V_{DDQ}$  terminals only.
4. Input terminals only.
5. I/O terminals only.
6. This is a steady-state DC parameter that applies after the power supply has reached its nominal operating value. Power sequencing is not necessary; however, the voltage on any input or I/O pin cannot exceed  $V_{DDQ}$  during power supply ramp up.
7.  $T_A$  is the "instant on" case temperature.

| Symbol           | Parameter <sup>(1)</sup> | Conditions             | Max. | Unit |
|------------------|--------------------------|------------------------|------|------|
| C <sub>IN</sub>  | Input Capacitance        | V <sub>IN</sub> = 3dV  | 7    | pF   |
| C <sub>I/O</sub> | I/O Capacitance          | V <sub>OUT</sub> = 3dV | 7    | pF   |

4875 thl 07a

## Pin Configuration — 128K x 36, 119 BGA

|   | 1     | 2      | 3      | 4      | 5      | 6      | 7     |
|---|-------|--------|--------|--------|--------|--------|-------|
| A | VDDQ  | A6     | A4     | NC(2)  | A8     | A16    | VDDQ  |
| B | NC    | CE2    | A3     | ADV/LD | A9     | CE2    | NC    |
| C | NC    | A7     | A2     | VDD    | A12    | A15    | NC    |
| D | I/O16 | I/OP3  | VSS    | NC     | VSS    | I/OP2  | I/O15 |
| E | I/O17 | I/O18  | VSS    | CE1    | VSS    | I/O13  | I/O14 |
| F | VDDQ  | I/O19  | VSS    | OE     | VSS    | I/O12  | VDDQ  |
| G | I/O20 | I/O21  | BW3    | NC(2)  | BW2    | I/O11  | I/O10 |
| H | I/O22 | I/O23  | VSS    | R/W    | VSS    | I/O9   | I/O8  |
| J | VDDQ  | VDD    | VDD(1) | VDD    | VDD(1) | VDD    | VDDQ  |
| K | I/O24 | I/O26  | VSS    | CLK    | VSS    | I/O6   | I/O7  |
| L | I/O25 | I/O27  | BW4    | NC     | BW1    | I/O4   | I/O5  |
| M | VDDQ  | I/O28  | VSS    | CEN    | VSS    | I/O3   | VDDQ  |
| N | I/O29 | I/O30  | VSS    | A1     | VSS    | I/O2   | I/O1  |
| P | I/O31 | I/OP4  | VSS    | A0     | VSS    | I/O0   | I/OP1 |
| R | NC    | A5     | LBO    | VDD    | VDD(1) | A13    | NC    |
| T | NC    | NC     | A10    | A11    | A14    | NC     | NC(4) |
| U | VDDQ  | DNU(3) | DNU(3) | DNU(3) | DNU(3) | DNU(3) | VDDQ  |

4875 drw 13a

### Top View

## Pin Configuration — 256K x 18, 119 BGA

|   | 1     | 2      | 3      | 4      | 5      | 6      | 7     |
|---|-------|--------|--------|--------|--------|--------|-------|
| A | VDDQ  | A6     | A4     | NC(2)  | A8     | A16    | VDDQ  |
| B | NC    | CE2    | A3     | ADV/LD | A9     | CE2    | NC    |
| C | NC    | A7     | A2     | VDD    | A13    | A17    | NC    |
| D | I/O8  | NC     | VSS    | NC     | VSS    | I/O7   | NC    |
| E | NC    | I/O9   | VSS    | CE1    | VSS    | NC     | I/O6  |
| F | VDDQ  | NC     | VSS    | OE     | VSS    | I/O5   | VDDQ  |
| G | NC    | I/O10  | BW2    | NC(2)  | VSS    | NC     | I/O4  |
| H | I/O11 | NC     | VSS    | R/W    | VSS    | I/O3   | NC    |
| J | VDDQ  | VDD    | VDD(1) | VDD    | VDD(1) | VDD    | VDDQ  |
| K | NC    | I/O12  | VSS    | CLK    | VSS    | NC     | I/O2  |
| L | I/O13 | NC     | VSS    | NC     | BW1    | I/O1   | NC    |
| M | VDDQ  | I/O14  | VSS    | CEN    | VSS    | NC     | VDDQ  |
| N | I/O15 | NC     | VSS    | A1     | VSS    | I/O0   | NC    |
| P | NC    | I/OP2  | VSS    | A0     | VSS    | NC     | I/OP1 |
| R | NC    | A5     | LBO    | VDD    | VDD(1) | A12    | NC    |
| T | NC    | A10    | A15    | NC     | A14    | A11    | NC(4) |
| U | VDDQ  | DNU(3) | DNU(3) | DNU(3) | DNU(3) | DNU(3) | VDDQ  |

4875 drw 13b

### Top View

#### NOTES:

1. J3, J5, and R5 do not have to be directly connected to VDD as long as the input voltage is  $\geq V_{IH}$ .
2. G4 and A4 are reserved for future 8M and 16M respectively.
3. DNU = Do not use; Pins U2, U3, U4, U5, and U6 are reserved for respective JTAG Pins: TMS, TDI, TCK, TDO and  $\overline{TRST}$  on future revisions. Within this current version, these pins are not connected.
4. On future revisions, T7 will be used for ZZ (sleep mode).

## Pin Configuration — 128K x 36, 165 fBGA

|   | 1                              | 2                              | 3                | 4                | 5                  | 6                | 7                              | 8               | 9                 | 10                | 11                   |
|---|--------------------------------|--------------------------------|------------------|------------------|--------------------|------------------|--------------------------------|-----------------|-------------------|-------------------|----------------------|
| A | NC <sup>(2)</sup>              | A7                             | $\overline{CE1}$ | $\overline{BW3}$ | $\overline{BW2}$   | $\overline{CE2}$ | $\overline{CEN}$               | ADV/LD          | NC <sup>(2)</sup> | A8                | NC                   |
| B | NC                             | A6                             | CE2              | $\overline{BW4}$ | $\overline{BW1}$   | CLK              | R/ $\overline{W}$              | $\overline{OE}$ | NC <sup>(2)</sup> | A9                | NC <sup>(2)</sup>    |
| C | I/O <sub>P3</sub>              | NC                             | V <sub>DDQ</sub> | V <sub>SS</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>SS</sub> | V <sub>DDQ</sub>  | NC                | I/O <sub>P2</sub>    |
| D | I/O <sub>17</sub>              | I/O <sub>16</sub>              | V <sub>DDQ</sub> | V <sub>DD</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>DD</sub> | V <sub>DDQ</sub>  | I/O <sub>15</sub> | I/O <sub>14</sub>    |
| E | I/O <sub>19</sub>              | I/O <sub>18</sub>              | V <sub>DDQ</sub> | V <sub>DD</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>DD</sub> | V <sub>DDQ</sub>  | I/O <sub>13</sub> | I/O <sub>12</sub>    |
| F | I/O <sub>21</sub>              | I/O <sub>20</sub>              | V <sub>DDQ</sub> | V <sub>DD</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>DD</sub> | V <sub>DDQ</sub>  | I/O <sub>11</sub> | I/O <sub>10</sub>    |
| G | I/O <sub>23</sub>              | I/O <sub>22</sub>              | V <sub>DDQ</sub> | V <sub>DD</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>DD</sub> | V <sub>DDQ</sub>  | I/O <sub>9</sub>  | I/O <sub>8</sub>     |
| H | V <sub>DD</sub> <sup>(1)</sup> | V <sub>DD</sub> <sup>(1)</sup> | NC               | V <sub>DD</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>DD</sub> | NC                | NC                | NC/ZZ <sup>(4)</sup> |
| J | I/O <sub>25</sub>              | I/O <sub>24</sub>              | V <sub>DDQ</sub> | V <sub>DD</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>DD</sub> | V <sub>DDQ</sub>  | I/O <sub>7</sub>  | I/O <sub>6</sub>     |
| K | I/O <sub>27</sub>              | I/O <sub>26</sub>              | V <sub>DDQ</sub> | V <sub>DD</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>DD</sub> | V <sub>DDQ</sub>  | I/O <sub>5</sub>  | I/O <sub>4</sub>     |
| L | I/O <sub>29</sub>              | I/O <sub>28</sub>              | V <sub>DDQ</sub> | V <sub>DD</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>DD</sub> | V <sub>DDQ</sub>  | I/O <sub>3</sub>  | I/O <sub>2</sub>     |
| M | I/O <sub>31</sub>              | I/O <sub>30</sub>              | V <sub>DDQ</sub> | V <sub>DD</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>DD</sub> | V <sub>DDQ</sub>  | I/O <sub>1</sub>  | I/O <sub>0</sub>     |
| N | I/O <sub>P4</sub>              | NC                             | V <sub>DDQ</sub> | V <sub>SS</sub>  | DNU <sup>(3)</sup> | NC               | V <sub>DD</sub> <sup>(1)</sup> | V <sub>SS</sub> | V <sub>DDQ</sub>  | NC                | I/O <sub>P1</sub>    |
| P | NC                             | NC <sup>(2)</sup>              | A5               | A2               | DNU <sup>(3)</sup> | A1               | DNU <sup>(3)</sup>             | A10             | A13               | A14               | NC                   |
| R | $\overline{LBO}$               | NC <sup>(2)</sup>              | A4               | A3               | DNU <sup>(3)</sup> | A0               | DNU <sup>(3)</sup>             | A11             | A12               | A15               | A16                  |

4875 tbl 25a

## Pin Configuration — 256K x 18, 165 fBGA

|   | 1                              | 2                              | 3                | 4                | 5                  | 6                | 7                              | 8               | 9                 | 10               | 11                   |
|---|--------------------------------|--------------------------------|------------------|------------------|--------------------|------------------|--------------------------------|-----------------|-------------------|------------------|----------------------|
| A | NC <sup>(2)</sup>              | A7                             | $\overline{CE1}$ | $\overline{BW2}$ | NC                 | $\overline{CE2}$ | $\overline{CEN}$               | ADV/LD          | NC <sup>(2)</sup> | A8               | A10                  |
| B | NC                             | A6                             | CE2              | NC               | $\overline{BW1}$   | CLK              | R/ $\overline{W}$              | $\overline{OE}$ | NC <sup>(2)</sup> | A9               | NC <sup>(2)</sup>    |
| C | NC                             | NC                             | V <sub>DDQ</sub> | V <sub>SS</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>SS</sub> | V <sub>DDQ</sub>  | NC               | I/O <sub>P1</sub>    |
| D | NC                             | I/O <sub>8</sub>               | V <sub>DDQ</sub> | V <sub>DD</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>DD</sub> | V <sub>DDQ</sub>  | NC               | I/O <sub>7</sub>     |
| E | NC                             | I/O <sub>9</sub>               | V <sub>DDQ</sub> | V <sub>DD</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>DD</sub> | V <sub>DDQ</sub>  | NC               | I/O <sub>6</sub>     |
| F | NC                             | I/O <sub>10</sub>              | V <sub>DDQ</sub> | V <sub>DD</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>DD</sub> | V <sub>DDQ</sub>  | NC               | I/O <sub>5</sub>     |
| G | NC                             | I/O <sub>11</sub>              | V <sub>DDQ</sub> | V <sub>DD</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>DD</sub> | V <sub>DDQ</sub>  | NC               | I/O <sub>4</sub>     |
| H | V <sub>DD</sub> <sup>(1)</sup> | V <sub>DD</sub> <sup>(1)</sup> | NC               | V <sub>DD</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>DD</sub> | NC                | NC               | NC/ZZ <sup>(4)</sup> |
| J | I/O <sub>12</sub>              | NC                             | V <sub>DDQ</sub> | V <sub>DD</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>DD</sub> | V <sub>DDQ</sub>  | I/O <sub>3</sub> | NC                   |
| K | I/O <sub>13</sub>              | NC                             | V <sub>DDQ</sub> | V <sub>DD</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>DD</sub> | V <sub>DDQ</sub>  | I/O <sub>2</sub> | NC                   |
| L | I/O <sub>14</sub>              | NC                             | V <sub>DDQ</sub> | V <sub>DD</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>DD</sub> | V <sub>DDQ</sub>  | I/O <sub>1</sub> | NC                   |
| M | I/O <sub>15</sub>              | NC                             | V <sub>DDQ</sub> | V <sub>DD</sub>  | V <sub>SS</sub>    | V <sub>SS</sub>  | V <sub>SS</sub>                | V <sub>DD</sub> | V <sub>DDQ</sub>  | I/O <sub>0</sub> | NC                   |
| N | I/O <sub>P2</sub>              | NC                             | V <sub>DDQ</sub> | V <sub>SS</sub>  | DNU <sup>(3)</sup> | NC               | V <sub>DD</sub> <sup>(1)</sup> | V <sub>SS</sub> | V <sub>DDQ</sub>  | NC               | NC                   |
| P | NC                             | NC <sup>(2)</sup>              | A5               | A2               | DNU <sup>(3)</sup> | A1               | DNU <sup>(3)</sup>             | A11             | A14               | A15              | NC                   |
| R | $\overline{LBO}$               | NC <sup>(2)</sup>              | A4               | A3               | DNU <sup>(3)</sup> | A0               | DNU <sup>(3)</sup>             | A12             | A13               | A16              | A17                  |

4875 tbl 25a

### NOTES:

- H1, H2, and N7 do not have to be directly connected to V<sub>DD</sub> as long as the input voltage is  $\geq V_{IH}$ .
- A9, B9, B11, A1, R2 and P2 are reserved for future 9M, 18M, 36M, 72M, 144M, and 288M respectively respectively.
- DNU = Do not use; Pins P5, P7, R5, R7 and N5 are reserved for respective JTAG pins: TDI, TDO, TMS, TCK and TRST on future revisions. Within this current version, these pins are not connected.
- On future revisions, H11 will be used for ZZ (sleep mode).

## Synchronous Truth Table<sup>(1)</sup>

| $\overline{\text{CEN}}$ | R/ $\overline{\text{W}}$ | Chip <sup>(6)</sup><br>Enable | ADV/ $\overline{\text{LD}}$ | $\overline{\text{BW}}_x$ | ADDRESS<br>USED | PREVIOUS CYCLE              | CURRENT CYCLE                                         | I/O<br>(2 cycles later) |
|-------------------------|--------------------------|-------------------------------|-----------------------------|--------------------------|-----------------|-----------------------------|-------------------------------------------------------|-------------------------|
| L                       | L                        | Select                        | L                           | Valid                    | External        | X                           | LOAD WRITE                                            | D <sup>(7)</sup>        |
| L                       | H                        | Select                        | L                           | X                        | External        | X                           | LOAD READ                                             | Q <sup>(7)</sup>        |
| L                       | X                        | X                             | H                           | Valid                    | Internal        | LOAD WRITE /<br>BURST WRITE | BURST WRITE<br>(Advance burst counter) <sup>(2)</sup> | D <sup>(7)</sup>        |
| L                       | X                        | X                             | H                           | X                        | Internal        | LOAD READ /<br>BURST READ   | BURST READ<br>(Advance burst counter) <sup>(2)</sup>  | Q <sup>(7)</sup>        |
| L                       | X                        | Deselect                      | L                           | X                        | X               | X                           | DESELECT or STOP <sup>(3)</sup>                       | HiZ                     |
| L                       | X                        | X                             | H                           | X                        | X               | DESELECT / NOOP             | NOOP                                                  | HiZ                     |
| H                       | X                        | X                             | X                           | X                        | X               | X                           | SUSPEND <sup>(4)</sup>                                | Previous Value          |

4875 tbl 08

### NOTES:

1. L = V<sub>IL</sub>, H = V<sub>IH</sub>, X = Don't Care.
2. When ADV/ $\overline{\text{LD}}$  signal is sampled high, the internal burst counter is incremented. The R/ $\overline{\text{W}}$  signal is ignored when the counter is advanced. Therefore the nature of the burst cycle (Read or Write) is determined by the status of the R/ $\overline{\text{W}}$  signal when the first address is loaded at the beginning of the burst cycle.
3. Deselect cycle is initiated when either ( $\overline{\text{CE}}_1$ , or  $\overline{\text{CE}}_2$  is sampled high or CE<sub>2</sub> is sampled low) and ADV/ $\overline{\text{LD}}$  is sampled low at rising edge of clock. The data bus will tri-state two cycles after deselect is initiated.
4. When  $\overline{\text{CEN}}$  is sampled high at the rising edge of clock, that clock edge is blocked from propagating through the part. The state of all the internal registers and the I/Os remains unchanged.
5. To select the chip requires  $\overline{\text{CE}}_1 = \text{L}$ ,  $\overline{\text{CE}}_2 = \text{L}$ , CE<sub>2</sub> = H on these chip enables. Chip is deselected if any one of the chip enables is false.
6. Device Outputs are ensured to be in High-Z after the first rising edge of clock upon power-up.
7. Q - Data read from the device, D - data written to the device.

## Partial Truth Table for Writes<sup>(1)</sup>

| OPERATION                                                      | R/ $\overline{\text{W}}$ | $\overline{\text{BW}}_1$ | $\overline{\text{BW}}_2$ | $\overline{\text{BW}}_3^{(3)}$ | $\overline{\text{BW}}_4^{(3)}$ |
|----------------------------------------------------------------|--------------------------|--------------------------|--------------------------|--------------------------------|--------------------------------|
| READ                                                           | H                        | X                        | X                        | X                              | X                              |
| WRITE ALL BYTES                                                | L                        | L                        | L                        | L                              | L                              |
| WRITE BYTE 1 (I/O[0:7], I/OP <sub>1</sub> ) <sup>(2)</sup>     | L                        | L                        | H                        | H                              | H                              |
| WRITE BYTE 2 (I/O[8:15], I/OP <sub>2</sub> ) <sup>(2)</sup>    | L                        | H                        | L                        | H                              | H                              |
| WRITE BYTE 3 (I/O[16:23], I/OP <sub>3</sub> ) <sup>(2,3)</sup> | L                        | H                        | H                        | L                              | H                              |
| WRITE BYTE 4 (I/O[24:31], I/OP <sub>4</sub> ) <sup>(2,3)</sup> | L                        | H                        | H                        | H                              | L                              |
| NO WRITE                                                       | L                        | H                        | H                        | H                              | H                              |

4875 tbl 09

### NOTES:

1. L = V<sub>IL</sub>, H = V<sub>IH</sub>, X = Don't Care.
2. Multiple bytes may be selected during the same cycle.
3. N/A for X18 configuration.

## Interleaved Burst Sequence Table ( $\overline{\text{LB0}}=\text{VDD}$ )

|                               | Sequence 1 |    | Sequence 2 |    | Sequence 3 |    | Sequence 4 |    |
|-------------------------------|------------|----|------------|----|------------|----|------------|----|
|                               | A1         | A0 | A1         | A0 | A1         | A0 | A1         | A0 |
| First Address                 | 0          | 0  | 0          | 1  | 1          | 0  | 1          | 1  |
| Second Address                | 0          | 1  | 0          | 0  | 1          | 1  | 1          | 0  |
| Third Address                 | 1          | 0  | 1          | 1  | 0          | 0  | 0          | 1  |
| Fourth Address <sup>(1)</sup> | 1          | 1  | 1          | 0  | 0          | 1  | 0          | 0  |

4875 tbl 10

### NOTE:

1. Upon completion of the Burst sequence the counter wraps around to its initial state and continues counting.

## Linear Burst Sequence Table ( $\overline{\text{LB0}}=\text{VSS}$ )

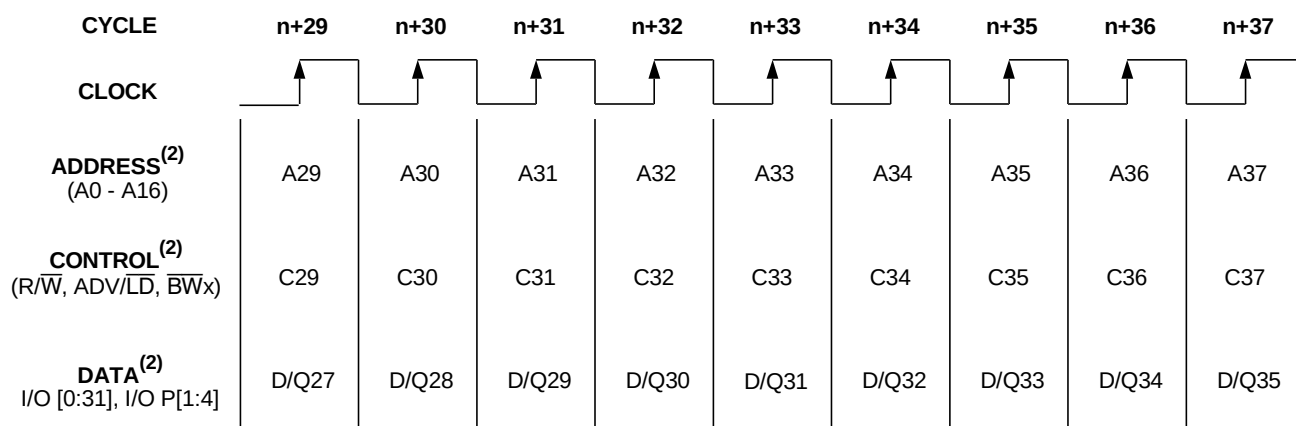
|                               | Sequence 1 |    | Sequence 2 |    | Sequence 3 |    | Sequence 4 |    |
|-------------------------------|------------|----|------------|----|------------|----|------------|----|
|                               | A1         | A0 | A1         | A0 | A1         | A0 | A1         | A0 |
| First Address                 | 0          | 0  | 0          | 1  | 1          | 0  | 1          | 1  |
| Second Address                | 0          | 1  | 1          | 0  | 1          | 1  | 0          | 0  |
| Third Address                 | 1          | 0  | 1          | 1  | 0          | 0  | 0          | 1  |
| Fourth Address <sup>(1)</sup> | 1          | 1  | 0          | 0  | 0          | 1  | 1          | 0  |

4875 tbl 11

### NOTE:

1. Upon completion of the Burst sequence the counter wraps around to its initial state and continues counting.

## Functional Timing Diagram<sup>(1)</sup>



4875 drw 03

### NOTES:

1. This assumes  $\overline{\text{CEN}}$ ,  $\overline{\text{CE1}}$ ,  $\text{CE2}$ ,  $\overline{\text{CE2}}$  are all true.
2. All Address, Control and Data\_In are only required to meet set-up and hold time with respect to the rising edge of clock. Data\_Out is valid after a clock-to-data delay from the rising edge of clock.

## Device Operation - Showint Mixed Load, Burst, Deselect and NOOP Cycles<sup>(2)</sup>

| Cycle | Address        | R/ $\overline{W}$ | ADV/ $\overline{LD}$ | $\overline{CE}^{(1)}$ | $\overline{CEN}$ | $\overline{BW}_x$ | $\overline{OE}$ | I/O              | Comments         |
|-------|----------------|-------------------|----------------------|-----------------------|------------------|-------------------|-----------------|------------------|------------------|
| n     | A <sub>0</sub> | H                 | L                    | L                     | L                | X                 | X               | X                | Load read        |
| n+1   | X              | X                 | H                    | X                     | L                | X                 | X               | X                | Burst read       |
| n+2   | A <sub>1</sub> | H                 | L                    | L                     | L                | X                 | L               | Q <sub>0</sub>   | Load read        |
| n+3   | X              | X                 | L                    | H                     | L                | X                 | L               | Q <sub>0+1</sub> | Deselect or STOP |
| n+4   | X              | X                 | H                    | X                     | L                | X                 | L               | Q <sub>1</sub>   | NOOP             |
| n+5   | A <sub>2</sub> | H                 | L                    | L                     | L                | X                 | X               | Z                | Load read        |
| n+6   | X              | X                 | H                    | X                     | L                | X                 | X               | Z                | Burst read       |
| n+7   | X              | X                 | L                    | H                     | L                | X                 | L               | Q <sub>2</sub>   | Deselect or STOP |
| n+8   | A <sub>3</sub> | L                 | L                    | L                     | L                | L                 | L               | Q <sub>2+1</sub> | Load write       |
| n+9   | X              | X                 | H                    | X                     | L                | L                 | X               | Z                | Burst write      |
| n+10  | A <sub>4</sub> | L                 | L                    | L                     | L                | L                 | X               | D <sub>3</sub>   | Load write       |
| n+11  | X              | X                 | L                    | H                     | L                | X                 | X               | D <sub>3+1</sub> | Deselect or STOP |
| n+12  | X              | X                 | H                    | X                     | L                | X                 | X               | D <sub>4</sub>   | NOOP             |
| n+13  | A <sub>5</sub> | L                 | L                    | L                     | L                | L                 | X               | Z                | Load write       |
| n+14  | A <sub>6</sub> | H                 | L                    | L                     | L                | X                 | X               | Z                | Load read        |
| n+15  | A <sub>7</sub> | L                 | L                    | L                     | L                | L                 | X               | D <sub>5</sub>   | Load write       |
| n+16  | X              | X                 | H                    | X                     | L                | L                 | L               | Q <sub>6</sub>   | Burst write      |
| n+17  | A <sub>8</sub> | H                 | L                    | L                     | L                | X                 | X               | D <sub>7</sub>   | Load read        |
| n+18  | X              | X                 | H                    | X                     | L                | X                 | X               | D <sub>7+1</sub> | Burst read       |
| n+19  | A <sub>9</sub> | L                 | L                    | L                     | L                | L                 | L               | Q <sub>8</sub>   | Load write       |

4875 tbl 12

### NOTES:

- $\overline{CE} = L$  is defined as  $\overline{CE}_1 = L$ ,  $\overline{CE}_2 = L$  and  $CE_2 = H$ .  $\overline{CE} = H$  is defined as  $\overline{CE}_1 = H$ ,  $\overline{CE}_2 = H$  or  $CE_2 = L$ .
- H = High; L = Low; X = Don't Care; Z = High Impedance.

## Read Operation<sup>(1)</sup>

| Cycle | Address        | R/ $\overline{W}$ | ADV/ $\overline{LD}$ | $\overline{CE}^{(2)}$ | $\overline{CEN}$ | $\overline{BW}_x$ | $\overline{OE}$ | I/O            | Comments                                    |
|-------|----------------|-------------------|----------------------|-----------------------|------------------|-------------------|-----------------|----------------|---------------------------------------------|
| n     | A <sub>0</sub> | H                 | L                    | L                     | L                | X                 | X               | X              | Address and Control meet setup              |
| n+1   | X              | X                 | X                    | X                     | L                | X                 | X               | X              | Clock Setup Valid                           |
| n+2   | X              | X                 | X                    | X                     | X                | X                 | L               | Q <sub>0</sub> | Contents of Address A <sub>0</sub> Read Out |

4875 tbl 13

### NOTES:

- H = High; L = Low; X = Don't Care; Z = High Impedance.
- $\overline{CE} = L$  is defined as  $\overline{CE}_1 = L$ ,  $\overline{CE}_2 = L$  and  $CE_2 = H$ .  $\overline{CE} = H$  is defined as  $\overline{CE}_1 = H$ ,  $\overline{CE}_2 = H$  or  $CE_2 = L$ .

## Burst Read Operation<sup>(1)</sup>

| Cycle | Address        | R/ $\overline{W}$ | ADV/ $\overline{LD}$ | $\overline{CE}^{(2)}$ | $\overline{CEN}$ | $\overline{BWx}$ | $\overline{OE}$ | I/O              | Comments                                               |
|-------|----------------|-------------------|----------------------|-----------------------|------------------|------------------|-----------------|------------------|--------------------------------------------------------|
| n     | A <sub>0</sub> | H                 | L                    | L                     | L                | X                | X               | X                | Address and Control meet setup                         |
| n+1   | X              | X                 | H                    | X                     | L                | X                | X               | X                | Clock Setup Valid, Advance Counter                     |
| n+2   | X              | X                 | H                    | X                     | L                | X                | L               | Q <sub>0</sub>   | Address A <sub>0</sub> Read Out, Inc. Count            |
| n+3   | X              | X                 | H                    | X                     | L                | X                | L               | Q <sub>0+1</sub> | Address A <sub>0+1</sub> Read Out, Inc. Count          |
| n+4   | X              | X                 | H                    | X                     | L                | X                | L               | Q <sub>0+2</sub> | Address A <sub>0+2</sub> Read Out, Inc. Count          |
| n+5   | A <sub>1</sub> | H                 | L                    | L                     | L                | X                | L               | Q <sub>0+3</sub> | Address A <sub>0+3</sub> Read Out, Load A <sub>1</sub> |
| n+6   | X              | X                 | H                    | X                     | L                | X                | L               | Q <sub>0</sub>   | Address A <sub>0</sub> Read Out, Inc. Count            |
| n+7   | X              | X                 | H                    | X                     | L                | X                | L               | Q <sub>1</sub>   | Address A <sub>1</sub> Read Out, Inc. Count            |
| n+8   | A <sub>2</sub> | H                 | L                    | L                     | L                | X                | L               | Q <sub>1+1</sub> | Address A <sub>1+1</sub> Read Out, Load A <sub>2</sub> |

4875 tbl 14

### NOTES:

- H = High; L = Low; X = Don't Care; Z = High Impedance..
- $\overline{CE} = L$  is defined as  $\overline{CE}_1 = L$ ,  $\overline{CE}_2 = L$  and  $CE_2 = H$ .  $\overline{CE} = H$  is defined as  $\overline{CE}_1 = H$ ,  $\overline{CE}_2 = H$  or  $CE_2 = L$ .

## Write Operation<sup>(1)</sup>

| Cycle | Address        | R/ $\overline{W}$ | ADV/ $\overline{LD}$ | $\overline{CE}^{(2)}$ | $\overline{CEN}$ | $\overline{BWx}$ | $\overline{OE}$ | I/O            | Comments                        |
|-------|----------------|-------------------|----------------------|-----------------------|------------------|------------------|-----------------|----------------|---------------------------------|
| n     | A <sub>0</sub> | L                 | L                    | L                     | L                | L                | X               | X              | Address and Control meet setup  |
| n+1   | X              | X                 | X                    | X                     | L                | X                | X               | X              | Clock Setup Valid               |
| n+2   | X              | X                 | X                    | X                     | L                | X                | X               | D <sub>0</sub> | Write to Address A <sub>0</sub> |

4875 tbl 15

### NOTES:

- H = High; L = Low; X = Don't Care; Z = High Impedance.
- $\overline{CE} = L$  is defined as  $\overline{CE}_1 = L$ ,  $\overline{CE}_2 = L$  and  $CE_2 = H$ .  $\overline{CE} = H$  is defined as  $\overline{CE}_1 = H$ ,  $\overline{CE}_2 = H$  or  $CE_2 = L$ .

## Burst Write Operation<sup>(1)</sup>

| Cycle | Address        | R/ $\overline{W}$ | ADV/ $\overline{LD}$ | $\overline{CE}^{(2)}$ | $\overline{CEN}$ | $\overline{BWx}$ | $\overline{OE}$ | I/O              | Comments                                            |
|-------|----------------|-------------------|----------------------|-----------------------|------------------|------------------|-----------------|------------------|-----------------------------------------------------|
| n     | A <sub>0</sub> | L                 | L                    | L                     | L                | L                | X               | X                | Address and Control meet setup                      |
| n+1   | X              | X                 | H                    | X                     | L                | L                | X               | X                | Clock Setup Valid, Inc. Count                       |
| n+2   | X              | X                 | H                    | X                     | L                | L                | X               | D <sub>0</sub>   | Address A <sub>0</sub> Write, Inc. Count            |
| n+3   | X              | X                 | H                    | X                     | L                | L                | X               | D <sub>0+1</sub> | Address A <sub>0+1</sub> Write, Inc. Count          |
| n+4   | X              | X                 | H                    | X                     | L                | L                | X               | D <sub>0+2</sub> | Address A <sub>0+2</sub> Write, Inc. Count          |
| n+5   | A <sub>1</sub> | L                 | L                    | L                     | L                | L                | X               | D <sub>0+3</sub> | Address A <sub>0+3</sub> Write, Load A <sub>1</sub> |
| n+6   | X              | X                 | H                    | X                     | L                | L                | X               | D <sub>0</sub>   | Address A <sub>0</sub> Write, Inc. Count            |
| n+7   | X              | X                 | H                    | X                     | L                | L                | X               | D <sub>1</sub>   | Address A <sub>1</sub> Write, Inc. Count            |
| n+8   | A <sub>2</sub> | L                 | L                    | L                     | L                | L                | X               | D <sub>1+1</sub> | Address A <sub>1+1</sub> Write, Load A <sub>2</sub> |

4875 tbl 16

### NOTES:

- H = High; L = Low; X = Don't Care; ? = Don't Know; Z = High Impedance.
- $\overline{CE} = L$  is defined as  $\overline{CE}_1 = L$ ,  $\overline{CE}_2 = L$  and  $CE_2 = H$ .  $\overline{CE} = H$  is defined as  $\overline{CE}_1 = H$ ,  $\overline{CE}_2 = H$  or  $CE_2 = L$ .

## Read Operation with Clock Enable Used<sup>(1)</sup>

| Cycle | Address        | R/ $\overline{W}$ | ADV/ $\overline{LD}$ | $\overline{CE}^{(2)}$ | $\overline{CEN}$ | BW <sub>x</sub> | $\overline{OE}$ | I/O            | Comments                                          |
|-------|----------------|-------------------|----------------------|-----------------------|------------------|-----------------|-----------------|----------------|---------------------------------------------------|
| n     | A <sub>0</sub> | H                 | L                    | L                     | L                | X               | X               | X              | Address and Control meet setup                    |
| n+1   | X              | X                 | X                    | X                     | H                | X               | X               | X              | Clock n+1 Ignored                                 |
| n+2   | A <sub>1</sub> | H                 | L                    | L                     | L                | X               | X               | X              | Clock Valid                                       |
| n+3   | X              | X                 | X                    | X                     | H                | X               | L               | Q <sub>0</sub> | Clock Ignored. Data Q <sub>0</sub> is on the bus. |
| n+4   | X              | X                 | X                    | X                     | H                | X               | L               | Q <sub>0</sub> | Clock Ignored. Data Q <sub>0</sub> is on the bus. |
| n+5   | A <sub>2</sub> | H                 | L                    | L                     | L                | X               | L               | Q <sub>0</sub> | Address A <sub>0</sub> Read out (bus trans.)      |
| n+6   | A <sub>3</sub> | H                 | L                    | L                     | L                | X               | L               | Q <sub>1</sub> | Address A <sub>1</sub> Read out (bus trans.)      |
| n+7   | A <sub>4</sub> | H                 | L                    | L                     | L                | X               | L               | Q <sub>2</sub> | Address A <sub>2</sub> Read out (bus trans.)      |

4875 tbl 17

### NOTES:

1. H = High; L = Low; X = Don't Care; Z = High Impedance.
2.  $\overline{CE} = L$  is defined as  $\overline{CE}_1 = L$ ,  $\overline{CE}_2 = L$  and  $CE_2 = H$ .  $\overline{CE} = H$  is defined as  $\overline{CE}_1 = H$ ,  $\overline{CE}_2 = H$  or  $CE_2 = L$ .

## Write Operation with Clock Enable Used<sup>(1)</sup>

| Cycle | Address        | R/ $\overline{W}$ | ADV/ $\overline{LD}$ | $\overline{CE}^{(2)}$ | $\overline{CEN}$ | BW <sub>x</sub> | $\overline{OE}$ | I/O            | Comments                        |
|-------|----------------|-------------------|----------------------|-----------------------|------------------|-----------------|-----------------|----------------|---------------------------------|
| n     | A <sub>0</sub> | L                 | L                    | L                     | L                | L               | X               | X              | Address and Control meet setup. |
| n+1   | X              | X                 | X                    | X                     | H                | X               | X               | X              | Clock n+1 Ignored.              |
| n+2   | A <sub>1</sub> | L                 | L                    | L                     | L                | L               | X               | X              | Clock Valid.                    |
| n+3   | X              | X                 | X                    | X                     | H                | X               | X               | X              | Clock Ignored.                  |
| n+4   | X              | X                 | X                    | X                     | H                | X               | X               | X              | Clock Ignored.                  |
| n+5   | A <sub>2</sub> | L                 | L                    | L                     | L                | L               | X               | D <sub>0</sub> | Write Data D <sub>0</sub>       |
| n+6   | A <sub>3</sub> | L                 | L                    | L                     | L                | L               | X               | D <sub>1</sub> | Write Data D <sub>1</sub>       |
| n+7   | A <sub>4</sub> | L                 | L                    | L                     | L                | L               | X               | D <sub>2</sub> | Write Data D <sub>2</sub>       |

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### NOTES:

1. H = High; L = Low; X = Don't Care; Z = High Impedance.
2.  $\overline{CE} = L$  is defined as  $\overline{CE}_1 = L$ ,  $\overline{CE}_2 = L$  and  $CE_2 = H$ .  $\overline{CE} = H$  is defined as  $\overline{CE}_1 = H$ ,  $\overline{CE}_2 = H$  or  $CE_2 = L$ .

## Read Operation with Chip Enable Used<sup>(1)</sup>

| Cycle | Address        | R/ $\overline{W}$ | ADV/ $\overline{LD}$ | $\overline{CE}^{(2)}$ | $\overline{CEN}$ | $\overline{BWx}$ | $\overline{OE}$ | I/O <sup>(3)</sup> | Comments                                               |
|-------|----------------|-------------------|----------------------|-----------------------|------------------|------------------|-----------------|--------------------|--------------------------------------------------------|
| n     | X              | X                 | L                    | H                     | L                | X                | X               | ?                  | Deselected.                                            |
| n+1   | X              | X                 | L                    | H                     | L                | X                | X               | ?                  | Deselected.                                            |
| n+2   | A <sub>0</sub> | H                 | L                    | L                     | L                | X                | X               | Z                  | Address and Control meet setup                         |
| n+3   | X              | X                 | L                    | H                     | L                | X                | X               | Z                  | Deselected or STOP.                                    |
| n+4   | A <sub>1</sub> | H                 | L                    | L                     | L                | X                | L               | Q <sub>0</sub>     | Address A <sub>0</sub> Read out. Load A <sub>1</sub> . |
| n+5   | X              | X                 | L                    | H                     | L                | X                | X               | Z                  | Deselected or STOP.                                    |
| n+6   | X              | X                 | L                    | H                     | L                | X                | L               | Q <sub>1</sub>     | Address A <sub>1</sub> Read out. Deselected.           |
| n+7   | A <sub>2</sub> | H                 | L                    | L                     | L                | X                | X               | Z                  | Address and control meet setup.                        |
| n+8   | X              | X                 | L                    | H                     | L                | X                | X               | Z                  | Deselected or STOP.                                    |
| n+9   | X              | X                 | L                    | H                     | L                | X                | L               | Q <sub>2</sub>     | Address A <sub>2</sub> Read out. Deselected.           |

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### NOTES:

1. H = High; L = Low; X = Don't Care; ? = Don't Know; Z = High Impedance.
2.  $\overline{CE} = L$  is defined as  $\overline{CE}_1 = L$ ,  $\overline{CE}_2 = L$  and  $CE_2 = H$ .  $\overline{CE} = H$  is defined as  $\overline{CE}_1 = H$ ,  $\overline{CE}_2 = H$  or  $CE_2 = L$ .
3. Device Outputs are ensured to be in High-Z after the first rising edge of clock upon power-up.

## Write Operation with Chip Enable Used<sup>(1)</sup>

| Cycle | Address        | R/ $\overline{W}$ | ADV/ $\overline{LD}$ | $\overline{CE}^{(2)}$ | $\overline{CEN}$ | $\overline{BWx}$ | $\overline{OE}$ | I/O <sup>(3)</sup> | Comments                                               |
|-------|----------------|-------------------|----------------------|-----------------------|------------------|------------------|-----------------|--------------------|--------------------------------------------------------|
| n     | X              | X                 | L                    | H                     | L                | X                | X               | ?                  | Deselected.                                            |
| n+1   | X              | X                 | L                    | H                     | L                | X                | X               | ?                  | Deselected.                                            |
| n+2   | A <sub>0</sub> | L                 | L                    | L                     | L                | L                | X               | Z                  | Address and Control meet setup                         |
| n+3   | X              | X                 | L                    | H                     | L                | X                | X               | Z                  | Deselected or STOP.                                    |
| n+4   | A <sub>1</sub> | L                 | L                    | L                     | L                | L                | X               | D <sub>0</sub>     | Address D <sub>0</sub> Write in. Load A <sub>1</sub> . |
| n+5   | X              | X                 | L                    | H                     | L                | X                | X               | Z                  | Deselected or STOP.                                    |
| n+6   | X              | X                 | L                    | H                     | L                | X                | X               | D <sub>1</sub>     | Address D <sub>1</sub> Write in. Deselected.           |
| n+7   | A <sub>2</sub> | L                 | L                    | L                     | L                | L                | X               | Z                  | Address and control meet setup.                        |
| n+8   | X              | X                 | L                    | H                     | L                | X                | X               | Z                  | Deselected or STOP.                                    |
| n+9   | X              | X                 | L                    | H                     | L                | X                | X               | D <sub>2</sub>     | Address D <sub>2</sub> Write in. Deselected.           |

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### NOTES:

1. H = High; L = Low; X = Don't Care; ? = Don't Know; Z = High Impedance.
2.  $\overline{CE} = L$  is defined as  $\overline{CE}_1 = L$ ,  $\overline{CE}_2 = L$  and  $CE_2 = H$ .  $\overline{CE} = H$  is defined as  $\overline{CE}_1 = H$ ,  $\overline{CE}_2 = H$  or  $CE_2 = L$ .

## DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range ( $V_{DD} = 3.3V \pm 5\%$ )

| Symbol     | Parameter                                | Test Conditions                                        | Min. | Max. | Unit    |
|------------|------------------------------------------|--------------------------------------------------------|------|------|---------|
| $ I_{LI} $ | Input Leakage Current                    | $V_{DD} = \text{Max.}, V_{IN} = 0V \text{ to } V_{DD}$ | —    | 5    | $\mu A$ |
| $ I_{LI} $ | LBO Input Leakage Current <sup>(1)</sup> | $V_{DD} = \text{Max.}, V_{IN} = 0V \text{ to } V_{DD}$ | —    | 30   | $\mu A$ |
| $ I_{LO} $ | Output Leakage Current                   | $V_{OUT} = 0V \text{ to } V_{DDQ}$ , Device Deselected | —    | 5    | $\mu A$ |
| $V_{OL}$   | Output Low Voltage                       | $I_{OL} = +6mA$ , $V_{DD} = \text{Min.}$               | —    | 0.4  | V       |
| $V_{OH}$   | Output High Voltage                      | $I_{OH} = -6mA$ , $V_{DD} = \text{Min.}$               | 2.0  | —    | V       |

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### NOTE:

- The  $\overline{LBO}$  pin will be internally pulled to  $V_{DD}$  if it is not actively driven in the application.

## DC Electrical Characteristics Over the Operating Temperature Supply Voltage Range<sup>(1)</sup> ( $V_{DD} = 3.3V \pm 5\%$ )

| Symbol    | Parameter                          | Test Conditions                                                                                                                                               | 200MHz     | 166MHz |     | 133MHz |     | 100MHz |     | Unit |
|-----------|------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------|------------|--------|-----|--------|-----|--------|-----|------|
|           |                                    |                                                                                                                                                               | Com'l Only | Com'l  | Ind | Com'l  | Ind | Com'l  | Ind |      |
| $I_{DD}$  | Operating Power Supply Current     | Device Selected, Outputs Open, $ADV/LD = X$ , $V_{DD} = \text{Max.}$ , $V_{IN} \geq V_{IH}$ or $\leq V_{IL}$ , $f = f_{MAX}$ <sup>(2)</sup>                   | 400        | 350    | 360 | 300    | 310 | 250    | 260 | mA   |
| $I_{SB1}$ | CMOS Standby Power Supply Current  | Device Deselected, Outputs Open, $V_{DD} = \text{Max.}$ , $V_{IN} \geq V_{HD}$ or $\leq V_{LD}$ , $f = 0$ <sup>(2,3)</sup>                                    | 40         | 40     | 45  | 40     | 45  | 40     | 45  | mA   |
| $I_{SB2}$ | Clock Running Power Supply Current | Device Deselected, Outputs Open, $V_{DD} = \text{Max.}$ , $V_{IN} \geq V_{HD}$ or $\leq V_{LD}$ , $f = f_{MAX}$ <sup>(2,3)</sup>                              | 130        | 120    | 130 | 110    | 120 | 100    | 110 | mA   |
| $I_{SB3}$ | Idle Power Supply Current          | Device Selected, Outputs Open, $\overline{CEN} \geq V_{IH}$ , $V_{DD} = \text{Max.}$ , $V_{IN} \geq V_{HD}$ or $\leq V_{LD}$ , $f = f_{MAX}$ <sup>(2,3)</sup> | 40         | 40     | 45  | 40     | 45  | 40     | 45  | mA   |

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### NOTES:

- All values are maximum guaranteed values.
- At  $f = f_{MAX}$ , inputs are cycling at the maximum frequency of read cycles of  $1/t_{CYC}$ ;  $f=0$  means no input lines are changing.
- For I/Os  $V_{HD} = V_{DDQ} - 0.2V$ ,  $V_{LD} = 0.2V$ . For other inputs  $V_{HD} = V_{DD} - 0.2V$ ,  $V_{LD} = 0.2V$ .

## AC Test Loads

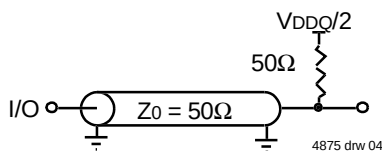


Figure 1. AC Test Load

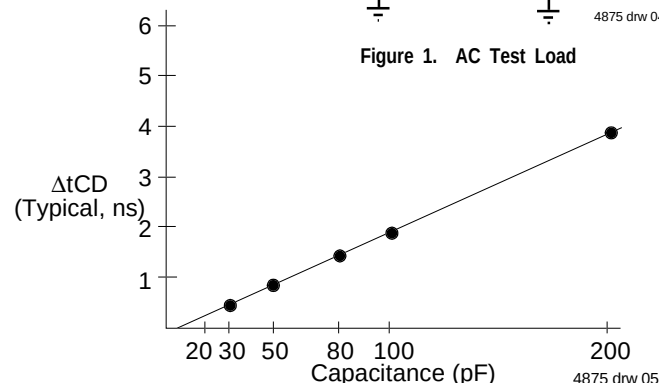


Figure 2. Lumped Capacitive Load, Typical Derating

## AC Test Conditions ( $V_{DDQ} = 2.5V$ )

|                                |                 |
|--------------------------------|-----------------|
| Input Pulse Levels             | 0 to 2.5V       |
| Input Rise/Fall Times          | 2ns             |
| Input Timing Reference Levels  | ( $V_{DDQ}/2$ ) |
| Output Timing Reference Levels | ( $V_{DDQ}/2$ ) |
| AC Test Load                   | See Figure 1    |

4875 tbl 23

## AC Electrical Characteristics

(V<sub>DD</sub> = 3.3V±5%, Commercial and Industrial Temperature Ranges)

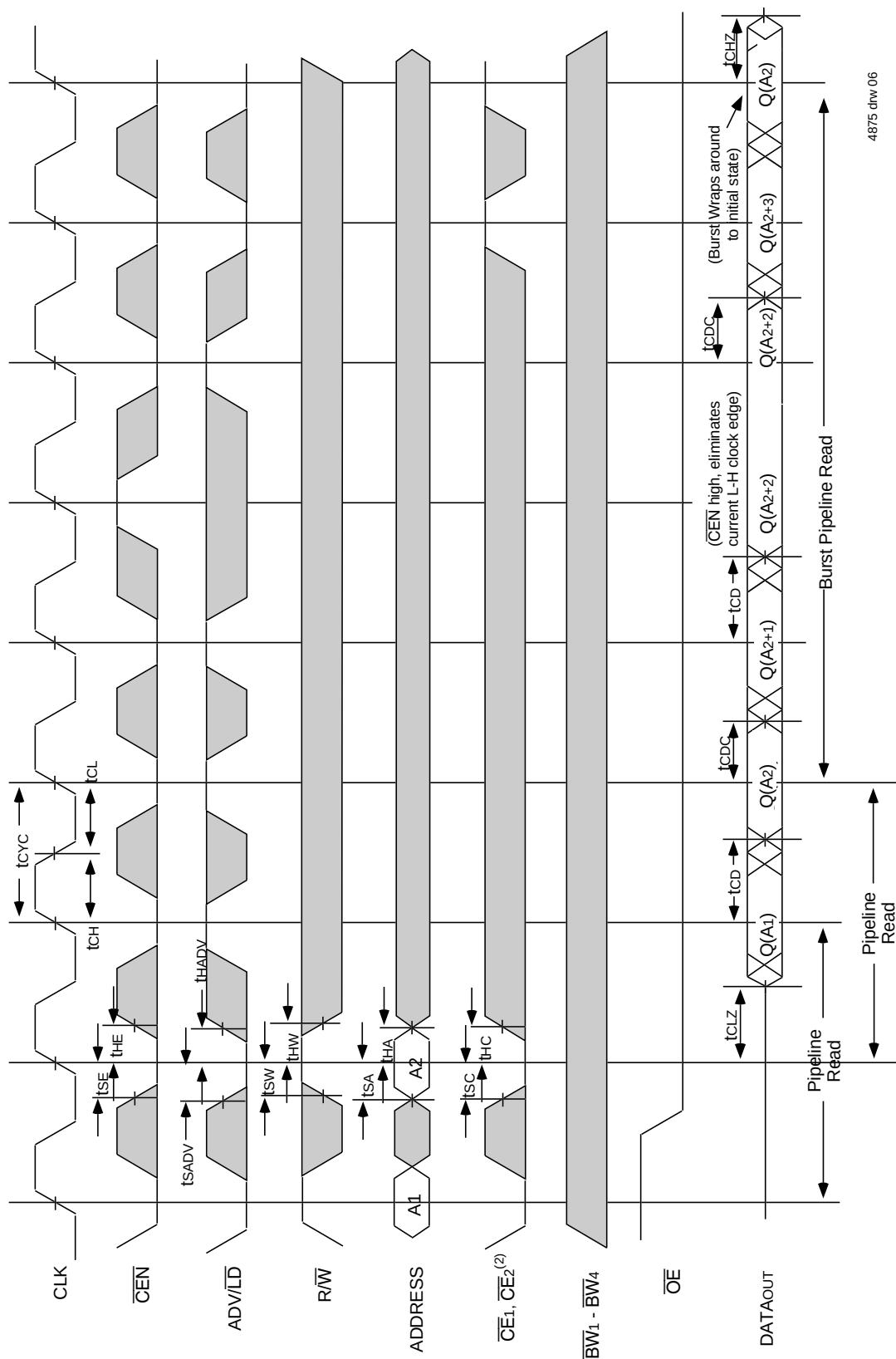
| Symbol                              | Parameter                          | 200MHz |      | 166MHz |      | 133MHz |      | 100MHz |      | Unit |
|-------------------------------------|------------------------------------|--------|------|--------|------|--------|------|--------|------|------|
|                                     |                                    | Min.   | Max. | Min.   | Max. | Min.   | Max. | Min.   | Max. |      |
| t <sub>CYC</sub>                    | Clock Cycle Time                   | 5      | —    | 6      | —    | 7.5    | —    | 10     | —    | ns   |
| f <sub>clk</sub> <sup>(1)</sup>     | Clock Frequency                    | —      | 200  | —      | 166  | —      | 133  | —      | 100  | MHz  |
| t <sub>CH</sub> <sup>(2)</sup>      | Clock High Pulse Width             | 1.8    | —    | 1.8    | —    | 2.2    | —    | 3.2    | —    | ns   |
| t <sub>CL</sub> <sup>(2)</sup>      | Clock Low Pulse Width              | 1.8    | —    | 1.8    | —    | 2.2    | —    | 3.2    | —    | ns   |
| <b>Output Parameters</b>            |                                    |        |      |        |      |        |      |        |      |      |
| t <sub>CD</sub>                     | Clock High to Valid Data           | —      | 3.2  | —      | 3.5  | —      | 4.2  | —      | 5    | ns   |
| t <sub>DC</sub>                     | Clock High to Data Change          | 1      | —    | 1      | —    | 1      | —    | 1      | —    | ns   |
| t <sub>CLZ</sub> <sup>(3,4,5)</sup> | Clock High to Output Active        | 1      | —    | 1      | —    | 1      | —    | 1      | —    | ns   |
| t <sub>CHZ</sub> <sup>(3,4,5)</sup> | Clock High to Data High-Z          | 1      | 3    | 1      | 3    | 1      | 3    | 1      | 3    | ns   |
| t <sub>OE</sub>                     | Output Enable Access Time          | —      | 3.2  | —      | 3.5  | —      | 4.2  | —      | 5    | ns   |
| t <sub>OLZ</sub> <sup>(3,4)</sup>   | Output Enable Low to Data Active   | 0      | —    | 0      | —    | 0      | —    | 0      | —    | ns   |
| t <sub>OHZ</sub> <sup>(3,4)</sup>   | Output Enable High to Data High-Z  | —      | 3.5  | —      | 3.5  | —      | 4.2  | —      | 5    | ns   |
| <b>Set Up Times</b>                 |                                    |        |      |        |      |        |      |        |      |      |
| t <sub>SE</sub>                     | Clock Enable Setup Time            | 1.5    | —    | 1.5    | —    | 1.7    | —    | 2.0    | —    | ns   |
| t <sub>SA</sub>                     | Address Setup Time                 | 1.5    | —    | 1.5    | —    | 1.7    | —    | 2.0    | —    | ns   |
| t <sub>SD</sub>                     | Data In Setup Time                 | 1.5    | —    | 1.5    | —    | 1.7    | —    | 2.0    | —    | ns   |
| t <sub>SW</sub>                     | Read/Write (R/W) Setup Time        | 1.5    | —    | 1.5    | —    | 1.7    | —    | 2.0    | —    | ns   |
| t <sub>ADV</sub>                    | Advance/Load (ADV/LD) Setup Time   | 1.5    | —    | 1.5    | —    | 1.7    | —    | 2.0    | —    | ns   |
| t <sub>SC</sub>                     | Chip Enable/Select Setup Time      | 1.5    | —    | 1.5    | —    | 1.7    | —    | 2.0    | —    | ns   |
| t <sub>SB</sub>                     | Byte Write Enable (BWx) Setup Time | 1.5    | —    | 1.5    | —    | 1.7    | —    | 2.0    | —    | ns   |
| <b>Hold Times</b>                   |                                    |        |      |        |      |        |      |        |      |      |
| t <sub>HE</sub>                     | Clock Enable Hold Time             | 0.5    | —    | 0.5    | —    | 0.5    | —    | 0.5    | —    | ns   |
| t <sub>HA</sub>                     | Address Hold Time                  | 0.5    | —    | 0.5    | —    | 0.5    | —    | 0.5    | —    | ns   |
| t <sub>HD</sub>                     | Data In Hold Time                  | 0.5    | —    | 0.5    | —    | 0.5    | —    | 0.5    | —    | ns   |
| t <sub>HW</sub>                     | Read/Write (R/W) Hold Time         | 0.5    | —    | 0.5    | —    | 0.5    | —    | 0.5    | —    | ns   |
| t <sub>HADV</sub>                   | Advance/Load (ADV/LD) Hold Time    | 0.5    | —    | 0.5    | —    | 0.5    | —    | 0.5    | —    | ns   |
| t <sub>HC</sub>                     | Chip Enable/Select Hold Time       | 0.5    | —    | 0.5    | —    | 0.5    | —    | 0.5    | —    | ns   |
| t <sub>HB</sub>                     | Byte Write Enable (BWx) Hold Time  | 0.5    | —    | 0.5    | —    | 0.5    | —    | 0.5    | —    | ns   |

### NOTES:

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- t<sub>F</sub> = 1/t<sub>CYC</sub>.
- Measured as HIGH above 0.6V<sub>DDQ</sub> and LOW below 0.4V<sub>DDQ</sub>.
- Transition is measured ±200mV from steady-state.
- These parameters are guaranteed with the AC load (Figure 1) by device characterization. They are not production tested.
- To avoid bus contention, the output buffers are designed such that t<sub>CHZ</sub> (device turn-off) is about 1ns faster than t<sub>CLZ</sub> (device turn-on) at a given temperature and voltage. The specs as shown do not imply bus contention because t<sub>CLZ</sub> is a Min. parameter that is worse case at totally different test conditions (0 deg. C, 3.465V) than t<sub>CHZ</sub>, which is a Max. parameter (worse case at 70 deg. C, 3.135V).

## Timing Waveform of Read Cycle<sup>(1,2,3,4)</sup>

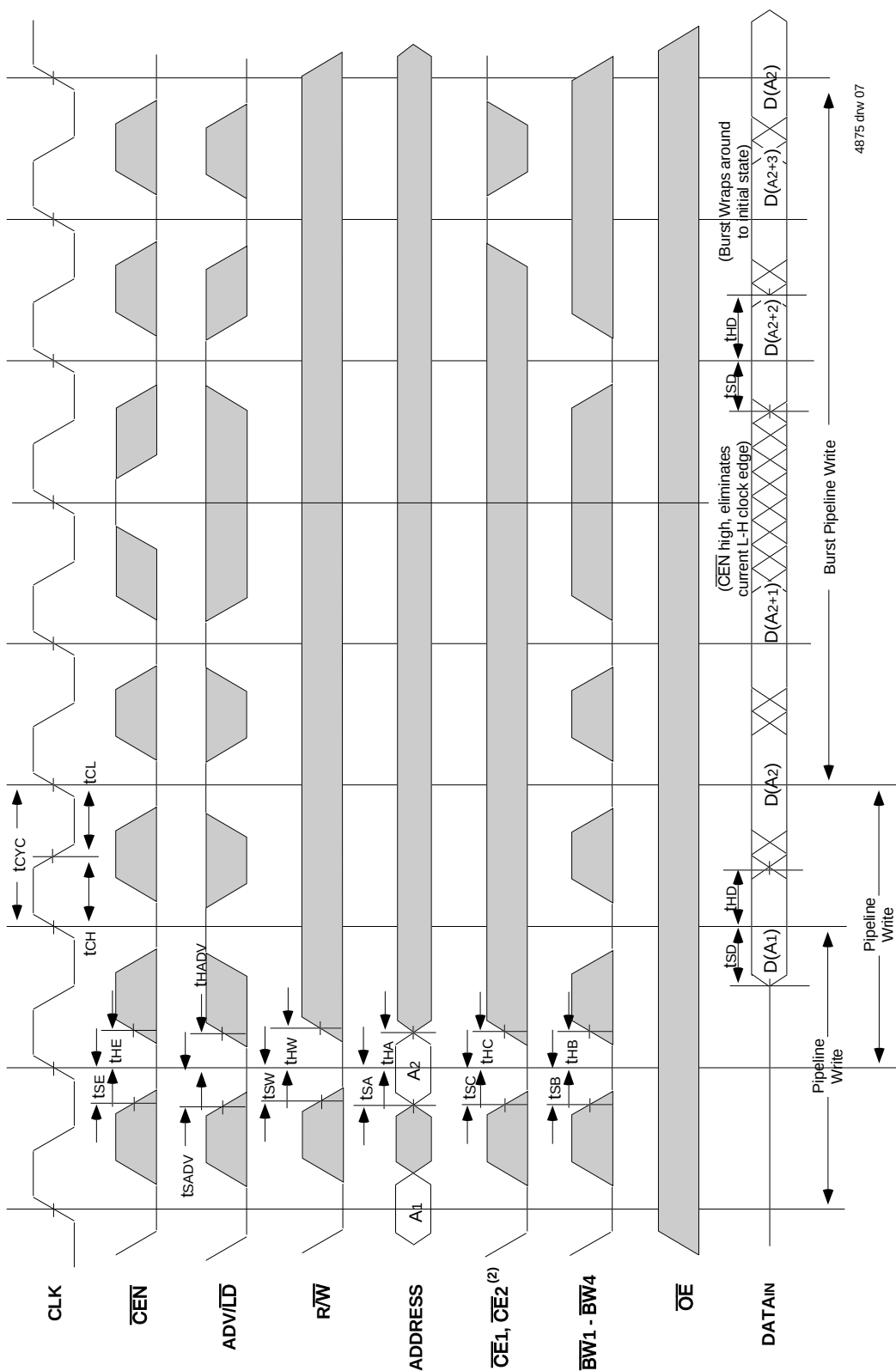


4875 drw 06

### NOTES:

1. Q(A<sub>1</sub>) represents the first output from the external address A<sub>1</sub>. Q(A<sub>2</sub>) represents the first output from the external address A<sub>2</sub>; Q(A<sub>2+1</sub>) represents the next output data in the burst sequence of the base address A<sub>2</sub>, etc. where address bits A<sub>0</sub> and A<sub>1</sub> are advancing for the four word burst in the sequence defined by the state of the LBO input.
2. CE<sub>2</sub> timing transitions are identical but inverted to the CE<sub>1</sub> and CE<sub>2</sub> signals. For example, when CE<sub>1</sub> and CE<sub>2</sub> are LOW on this waveform, CE<sub>2</sub> is HIGH.
3. Burst ends when new address and control are loaded into the SRAM by sampling ADV/LD LOW.
4. R/W is don't care when the SRAM is bursting (ADV/LD sampled HIGH). The nature of the burst access (Read or Write) is fixed by the state of the R/W signal when new address and control are loaded into the SRAM.

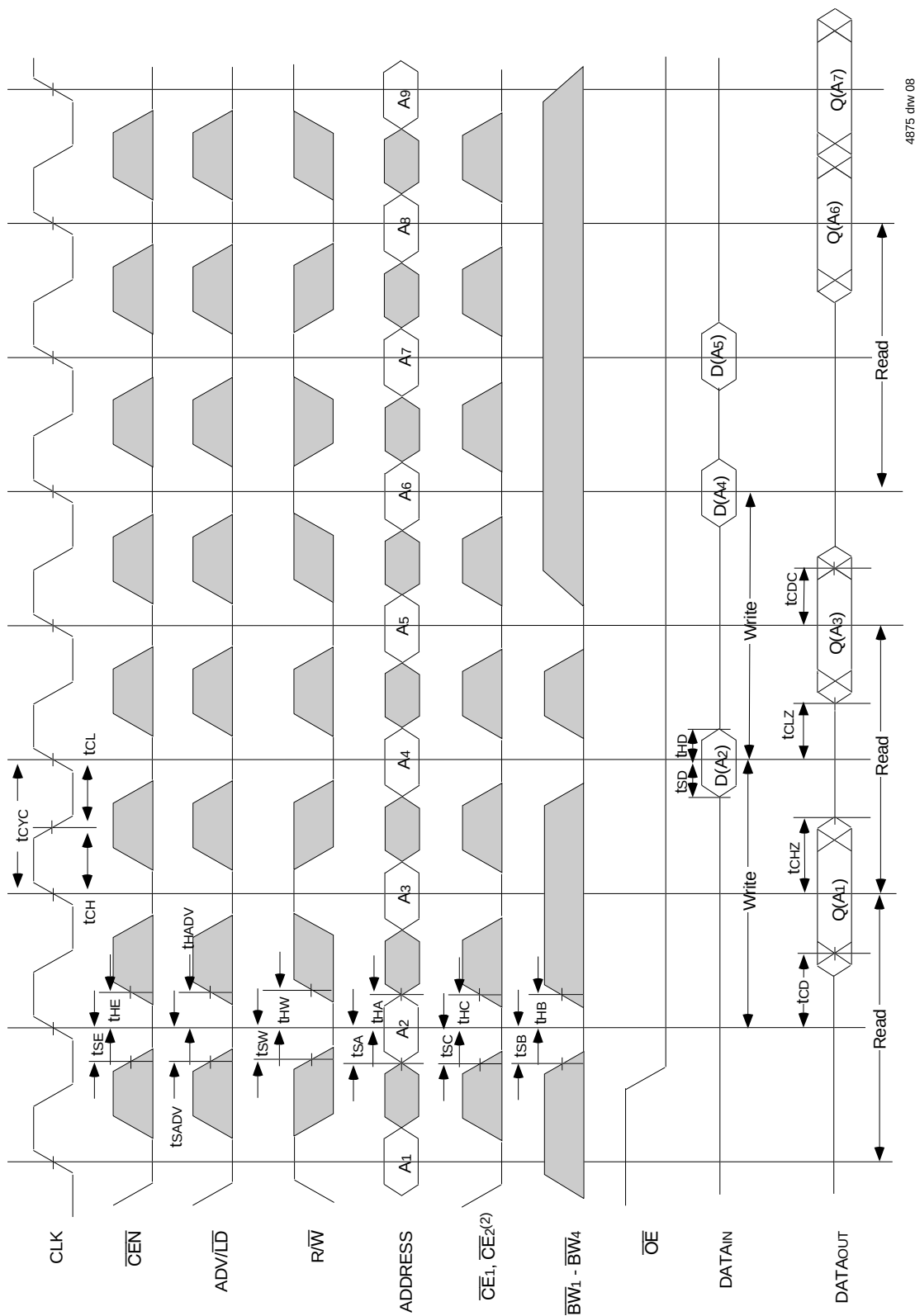
## Timing Waveform of Write Cycles(1,2,3,4,5)



### NOTES:

1.  $D(A_1)$  represents the first input to the external address  $A_1$ .  $D(A_2)$  represents the first input to the external address  $A_2$ .  $D(A_2+1)$  represents the next input data in the burst sequence of the base address  $A_2$ , etc. where address bits  $A_0$  and  $A_1$  are advancing for the four word burst in the sequence defined by the state of the  $\overline{LB0}$  input.
2.  $CE_2$  timing transitions are identical but inverted to the  $\overline{CE_1}$  and  $\overline{CE_2}$  signals. For example, when  $\overline{CE_1}$  and  $\overline{CE_2}$  are LOW on this waveform,  $CE_2$  is HIGH.
3. Burst ends when new address and control are loaded into the SRAM by sampling  $\overline{ADV/LD}$  LOW.
4.  $R/W$  is don't care when the SRAM is bursting ( $\overline{ADV/LD}$  sampled HIGH). The nature of the burst access (Read or Write) is fixed by the state of the  $R/W$  signal when new address and control are loaded into the SRAM.
5. Individual Byte Write signals ( $\overline{BWx}$ ) must be valid on all write and burst-write cycles. A write cycle is initiated when  $R/W$  signal is sampled LOW. The byte write information comes in two cycles before the actual data is presented to the SRAM.

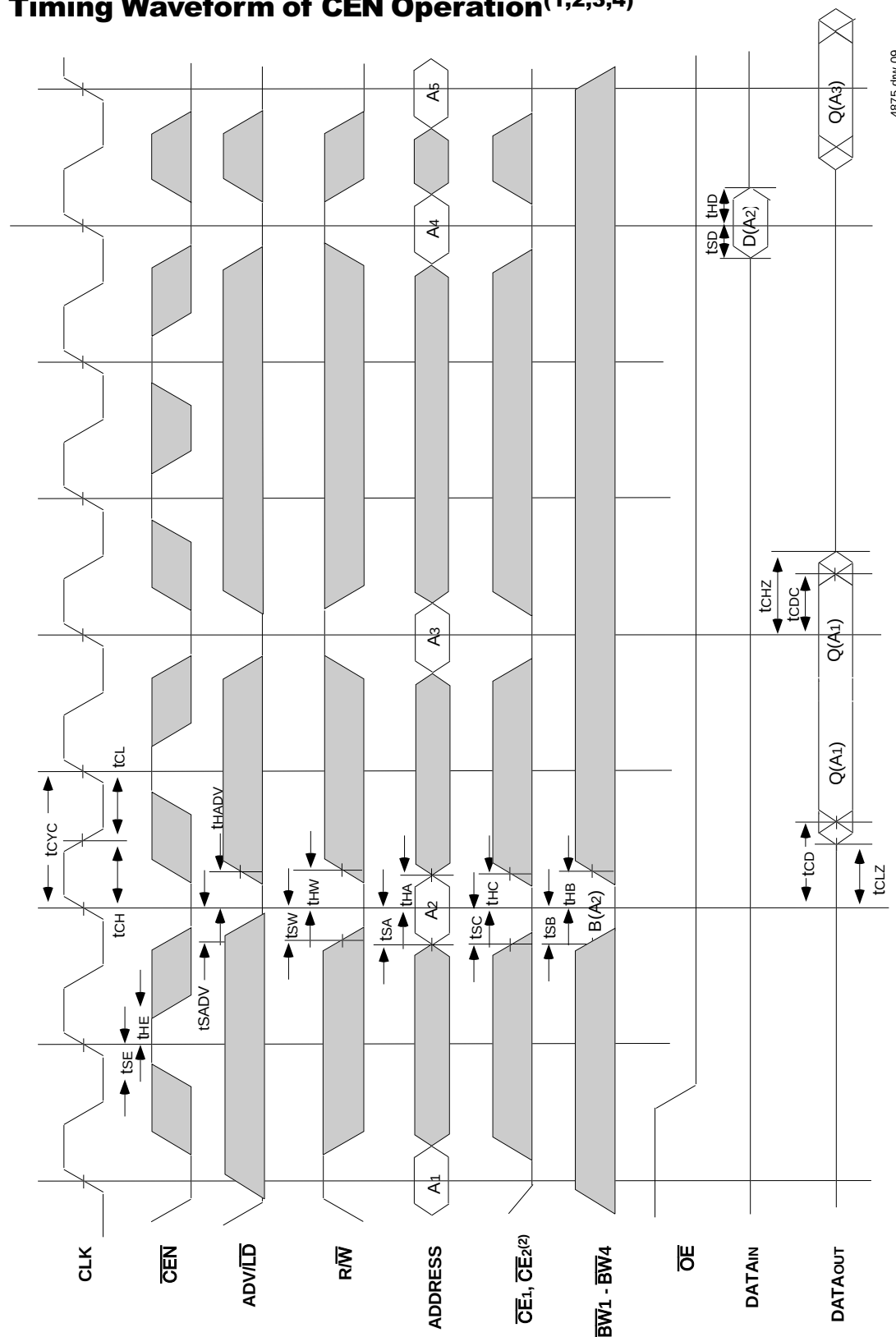
## Timing Waveform of Combined Read and Write Cycles (1,2,3)



### NOTES:

1. Q (A1) represents the first output from the external address A1. D (A2) represents the input data to the SRAM corresponding to address A2.
2. CE2 timing transitions are identical but inverted to the CE1 and OE2 signals. For example, when CE1 and OE2 are LOW on this waveform, CE2 is HIGH.
3. Individual Byte Write signals (BWx) must be valid on all write and burst-write cycles. A write cycle is initiated when RW signal is sampled LOW. The byte write information comes in two cycles before the actual data is presented to the SRAM.

## Timing Waveform of $\overline{\text{CEN}}$ Operation<sup>(1,2,3,4)</sup>

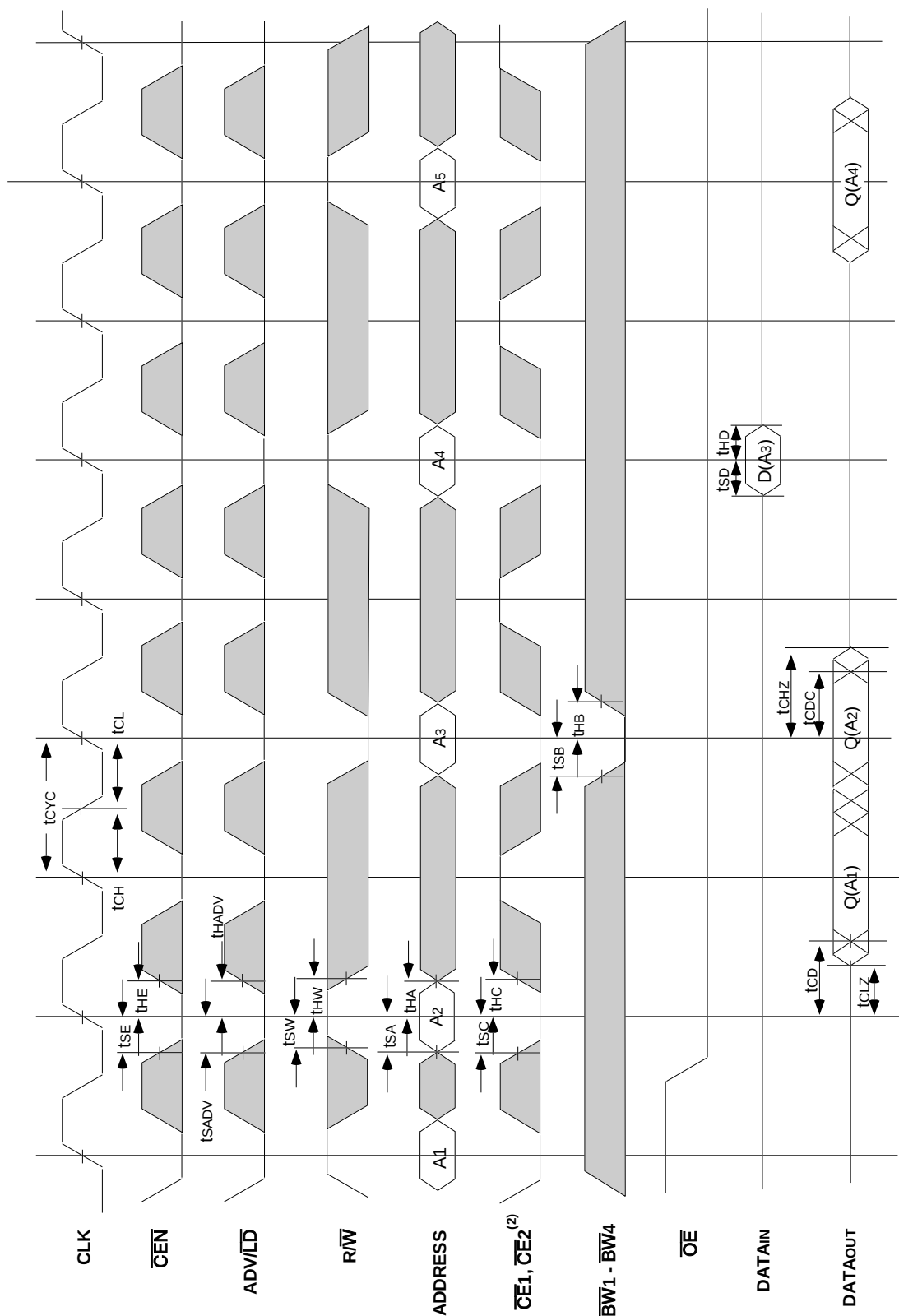


4875 d1w 09

### NOTES:

1. Q (A1) represents the first output from the external address A1. D (A2) represents the input data to the SRAM corresponding to address A2.
2. CE2 timing transitions are identical but inverted to the CE1 and CE2 signals. For example, when CE1 and CE2 are LOW on this waveform, CE2 is HIGH.
3.  $\overline{\text{CEN}}$  when sampled high on the rising edge of clock will block that L-H transition of the clock from propagating into the SRAM. The part will behave as if the L-H clock transition did not occur. All internal registers in the SRAM will retain their previous state.
4. Individual Byte Write signals ( $\overline{\text{BWx}}$ ) must be valid on all write and burst-write cycles. A write cycle is initiated when  $\overline{\text{R/W}}$  signal is sampled LOW. The byte write information comes in two cycles before the actual data is presented to the SRAM.

## Timing Waveform of $\overline{\text{CS}}$ Operation<sup>(1,2,3,4)</sup>



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### NOTES:

1. Q(A<sub>1</sub>) represents the first output from the external address A<sub>1</sub>. D(A<sub>3</sub>) represents the input data to the SRAM corresponding to address A<sub>3</sub>.
2. CE<sub>2</sub> timing transitions are identical but inverted to the CE<sub>1</sub> and CE<sub>2</sub> signals. For example, when CE<sub>1</sub> and CE<sub>2</sub> are LOW on this waveform, CE<sub>2</sub> is HIGH.
3.  $\overline{\text{CEN}}$  when sampled high on the rising edge of clock will block that L-H transition of the clock from propagating into the SRAM. The part will behave as if the L-H clock transition did not occur. All internal registers in the SRAM will retain their previous state.
4. Individual Byte Write signals ( $\overline{\text{BWx}}$ ) must be valid on all write and burst-write cycles. A write cycle is initiated when  $\overline{\text{RW}}$  signal is sampled LOW. The byte write information comes in two cycles before the actual data is presented to the SRAM.

**REVISIONS**

| CON | REV | DESCRIPTION | DATE | APPROVED |
|-----|-----|-------------|------|----------|
|     |     |             |      |          |

**TOP VIEW**

Dimensions:  $D$ ,  $D/2$ ,  $D1$ ,  $D1/2$ ,  $E$ ,  $E/2$ ,  $E1$ ,  $E1/2$ ,  $E1/4$ ,  $D1/4$ ,  $E1/4$ ,  $N$ ,  $1$ ,  $2$ ,  $3$ ,  $4$ ,  $14$ ,  $15$ ,  $16$ ,  $17$ ,  $18$ ,  $19$ ,  $20$ ,  $21$ ,  $22$ ,  $23$ ,  $24$ ,  $25$ ,  $26$ ,  $27$ ,  $28$ ,  $29$ ,  $30$ ,  $31$ ,  $32$ ,  $33$ ,  $34$ ,  $35$ ,  $36$ ,  $37$ ,  $38$ ,  $39$ ,  $40$ ,  $41$ ,  $42$ ,  $43$ ,  $44$ ,  $45$ ,  $46$ ,  $47$ ,  $48$ ,  $49$ ,  $50$ ,  $51$ ,  $52$ ,  $53$ ,  $54$ ,  $55$ ,  $56$ ,  $57$ ,  $58$ ,  $59$ ,  $60$ ,  $61$ ,  $62$ ,  $63$ ,  $64$ ,  $65$ ,  $66$ ,  $67$ ,  $68$ ,  $69$ ,  $70$ ,  $71$ ,  $72$ ,  $73$ ,  $74$ ,  $75$ ,  $76$ ,  $77$ ,  $78$ ,  $79$ ,  $80$ ,  $81$ ,  $82$ ,  $83$ ,  $84$ ,  $85$ ,  $86$ ,  $87$ ,  $88$ ,  $89$ ,  $90$ ,  $91$ ,  $92$ ,  $93$ ,  $94$ ,  $95$ ,  $96$ ,  $97$ ,  $98$ ,  $99$ ,  $100$ ,  $101$ ,  $102$ ,  $103$ ,  $104$ ,  $105$ ,  $106$ ,  $107$ ,  $108$ ,  $109$ ,  $110$ ,  $111$ ,  $112$ ,  $113$ ,  $114$ ,  $115$ ,  $116$ ,  $117$ ,  $118$ ,  $119$ ,  $120$ ,  $121$ ,  $122$ ,  $123$ ,  $124$ ,  $125$ ,  $126$ ,  $127$ ,  $128$ ,  $129$ ,  $130$ ,  $131$ ,  $132$ ,  $133$ ,  $134$ ,  $135$ ,  $136$ ,  $137$ ,  $138$ ,  $139$ ,  $140$ ,  $141$ ,  $142$ ,  $143$ ,  $144$ ,  $145$ ,  $146$ ,  $147$ ,  $148$ ,  $149$ ,  $150$ ,  $151$ ,  $152$ ,  $153$ ,  $154$ ,  $155$ ,  $156$ ,  $157$ ,  $158$ ,  $159$ ,  $160$ ,  $161$ ,  $162$ ,  $163$ ,  $164$ ,  $165$ ,  $166$ ,  $167$ ,  $168$ ,  $169$ ,  $170$ ,  $171$ ,  $172$ ,  $173$ ,  $174$ ,  $175$ ,  $176$ ,  $177$ ,  $178$ ,  $179$ ,  $180$ ,  $181$ ,  $182$ ,  $183$ ,  $184$ ,  $185$ ,  $186$ ,  $187$ ,  $188$ ,  $189$ ,  $190$ ,  $191$ ,  $192$ ,  $193$ ,  $194$ ,  $195$ ,  $196$ ,  $197$ ,  $198$ ,  $199$ ,  $200$ ,  $201$ ,  $202$ ,  $203$ ,  $204$ ,  $205$ ,  $206$ ,  $207$ ,  $208$ ,  $209$ ,  $210$ ,  $211$ ,  $212$ ,  $213$ ,  $214$ ,  $215$ ,  $216$ ,  $217$ ,  $218$ ,  $219$ ,  $220$ ,  $221$ ,  $222$ ,  $223$ ,  $224$ ,  $225$ ,  $226$ ,  $227$ ,  $228$ ,  $229$ ,  $230$ ,  $231$ ,  $232$ ,  $233$ ,  $234$ ,  $235$ ,  $236$ ,  $237$ ,  $238$ ,  $239$ ,  $240$ ,  $241$ ,  $242$ ,  $243$ ,  $244$ ,  $245$ ,  $246$ ,  $247$ ,  $248$ ,  $249$ ,  $250$ ,  $251$ ,  $252$ ,  $253$ ,  $254$ ,  $255$ ,  $256$ ,  $257$ ,  $258$ ,  $259$ ,  $260$ ,  $261$ ,  $262$ ,  $263$ ,  $264$ ,  $265$ ,  $266$ ,  $267$ ,  $268$ ,  $269$ ,  $270$ ,  $271$ ,  $272$ ,  $273$ ,  $274$ ,  $275$ ,  $276$ ,  $277$ ,  $278$ ,  $279$ ,  $280$ ,  $281$ ,  $282$ ,  $283$ ,  $284$ ,  $285$ ,  $286$ ,  $287$ ,  $288$ ,  $289$ ,  $290$ ,  $291$ ,  $292$ ,  $293$ ,  $294$ ,  $295$ ,  $296$ ,  $297$ ,  $298$ ,  $299$ ,  $300$ ,  $301$ ,  $302$ ,  $303$ ,  $304$ ,  $305$ ,  $306$ ,  $307$ ,  $308$ ,  $309$ ,  $310$ ,  $311$ ,  $312$ ,  $313$ ,  $314$ ,  $315$ ,  $316$ ,  $317$ ,  $318$ ,  $319$ ,  $320$ ,  $321$ ,  $322$ ,  $323$ ,  $324$ ,  $325$ ,  $326$ ,  $327$ ,  $328$ ,  $329$ ,  $330$ ,  $331$ ,  $332$ ,  $333$ ,  $334$ ,  $335$ ,  $336$ ,  $337$ ,  $338$ ,  $339$ ,  $340$ ,  $341$ ,  $342$ ,  $343$ ,  $344$ ,  $345$ ,  $346$ ,  $347$ ,  $348$ ,  $349$ ,  $350$ ,  $351$ ,  $352$ ,  $353$ ,  $354$ ,  $355$ ,  $356$ ,  $357$ ,  $358$ ,  $359$ ,  $360$ ,  $361$ ,  $362$ ,  $363$ ,  $364$ ,  $365$ ,  $366$ ,  $367$ ,  $368$ ,  $369$ ,  $370$ ,  $371$ ,  $372$ ,  $373$ ,  $374$ ,  $375$ ,  $376$ ,  $377$ ,  $378$ ,  $379$ ,  $380$ ,  $381$ ,  $382$ ,  $383$ ,  $384$ ,  $385$ ,  $386$ ,  $387$ ,  $388$ ,  $389$ ,  $390$ ,  $391$ ,  $392$ ,  $393$ ,  $394$ ,  $395$ ,  $396$ ,  $397$ ,  $398$ ,  $399$ ,  $400$ ,  $401$ ,  $402$ ,  $403$ ,  $404$ ,  $405$ ,  $406$ ,  $407$ ,  $408$ ,  $409$ ,  $410$ ,  $411$ ,  $412$ ,  $413$ ,  $414$ ,  $415$ ,  $416$ ,  $417$ ,  $418$ ,  $419$ ,  $420$ ,  $421$ ,  $422$ ,  $423$ ,  $424$ ,  $425$ ,  $426$ ,  $427$ ,  $428$ ,  $429$ ,  $430$ ,  $431$ ,  $432$ ,  $433$ ,  $434$ ,  $435$ ,  $436$ ,  $437$ ,  $438$ ,  $439$ ,  $440$ ,  $441$ ,  $442$ ,  $443$ ,  $444$ ,  $445$ ,  $446$ ,  $4$

| SYMBOL | JEDEC VARIATION |      |      | NOTE |
|--------|-----------------|------|------|------|
|        | DJ              |      |      |      |
|        | MIN             | NOM  | MAX  |      |
| A      | —               | —    | 1.60 |      |
| A1     | .05             | .10  | .15  |      |
| A2     | 1.35            | 1.40 | 1.45 |      |
| D      | 22.00 BSC       |      |      | 4    |
| D1     | 20.00 BSC       |      |      | 5,2  |
| E      | 16.00 BSC       |      |      |      |
| E1     | 14.00 BSC       |      |      | 5,2  |
| N      | 100             |      |      |      |
| ND     | 30              |      |      |      |
| NE     | 20              |      |      |      |
| e      | .65 BSC         |      |      |      |
| b      | .22             | .32  | .38  | 7    |
| b1     | .22             | .30  | .33  |      |
| ccc    | —               | —    | .10  |      |
| ddd    | —               | —    | .13  |      |

1 ALL DIMENSIONING AND TOLERANCING CONFORM TO ANSI Y14.5M-1982

2 TOP PACKAGE MAY BE SMALLER THAN BOTTOM PACKAGE BY .15 mm

3 DATUMS A-B AND D-D TO BE DETERMINED AT DATUM PLANE -H-

4 DIMENSIONS D AND E ARE TO BE DETERMINED AT SEATING PLANE -C-

5 DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION, ALLOWABLE MOLD PROTRUSION IS .25 mm PER SIDE. D1 AND E1 ARE MAXIMUM BODY SIZE DIMENSIONS INCLUDING MOLD MISMATCH

6 DETAILS OF PIN 1 IDENTIFIER IS OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED

7 DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION, ALLOWABLE DAMBAR PROTRUSION IS .08 mm IN EXCESS OF THE b DIMENSION AT MAXIMUM MATERIAL CONDITION, DAMBAR MUST BE LOCATED ON THE LOWER RADIUS OR THE FOOT.

8 EXACT SHAPE OF EACH CORNER IS OPTIONAL

9 THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN .10 AND .25 mm FROM THE LEAD TIP

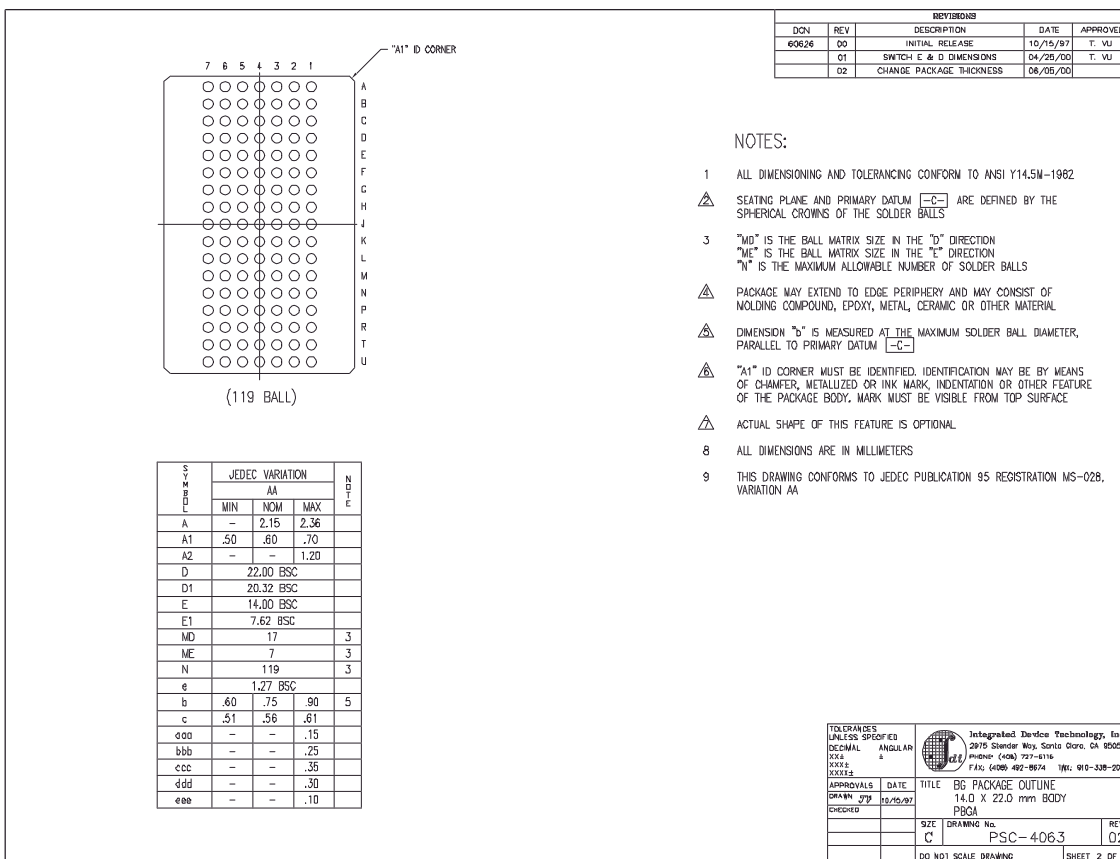
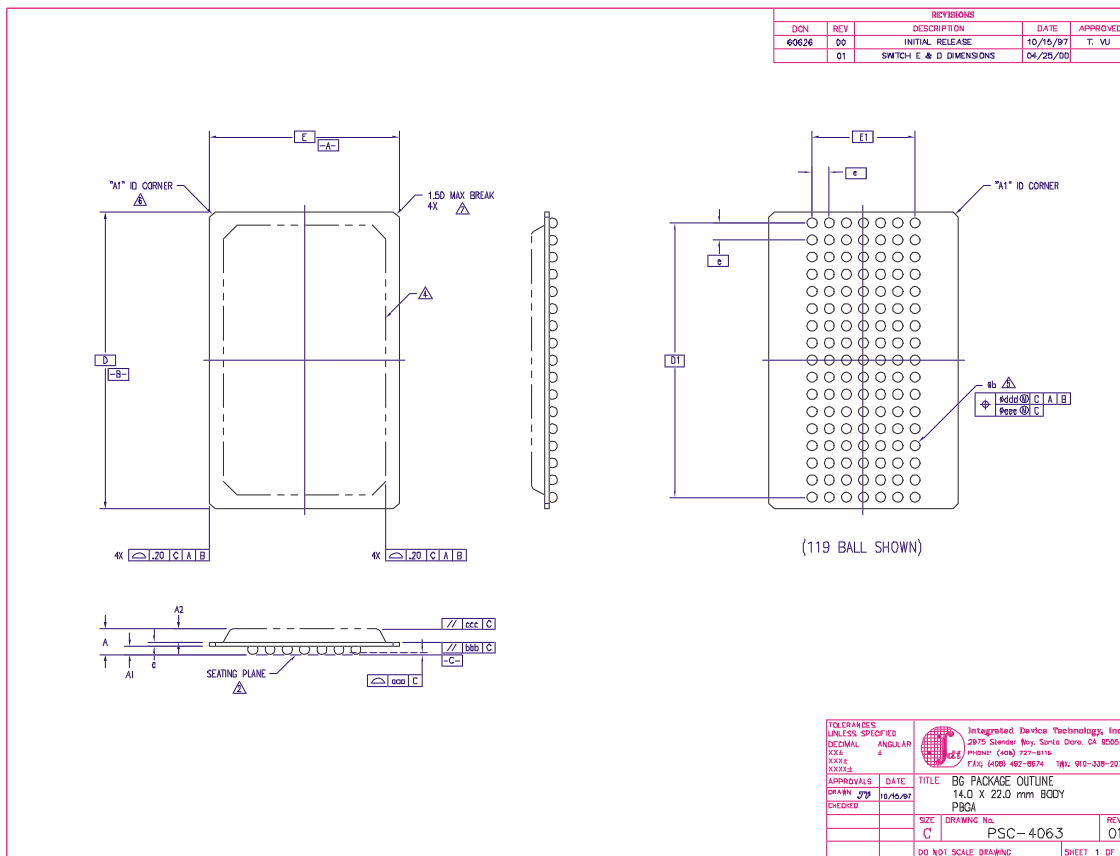
10 ALL DIMENSIONS ARE IN MILLIMETERS

11 THIS OUTLINE CONFORMS TO JEDEC PUBLICATION 95 REGISTRATION MO-136, VARIATION DL AND RX

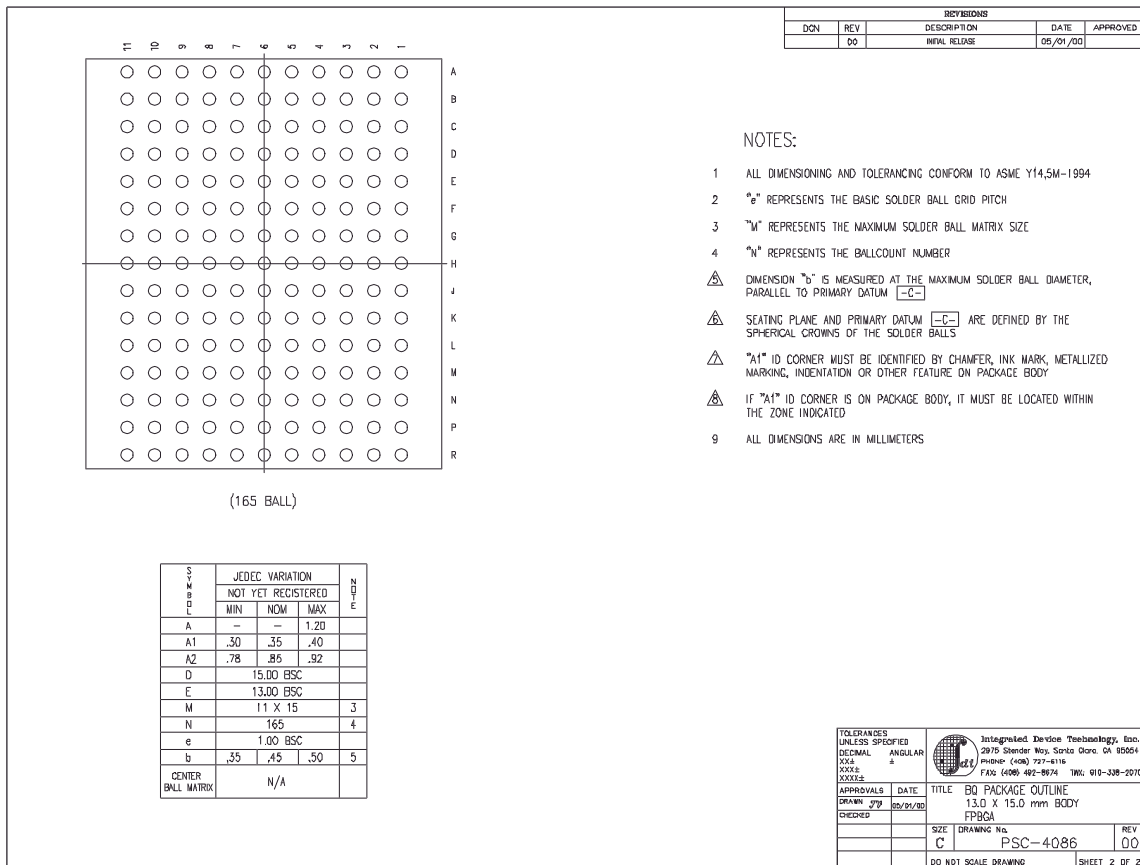
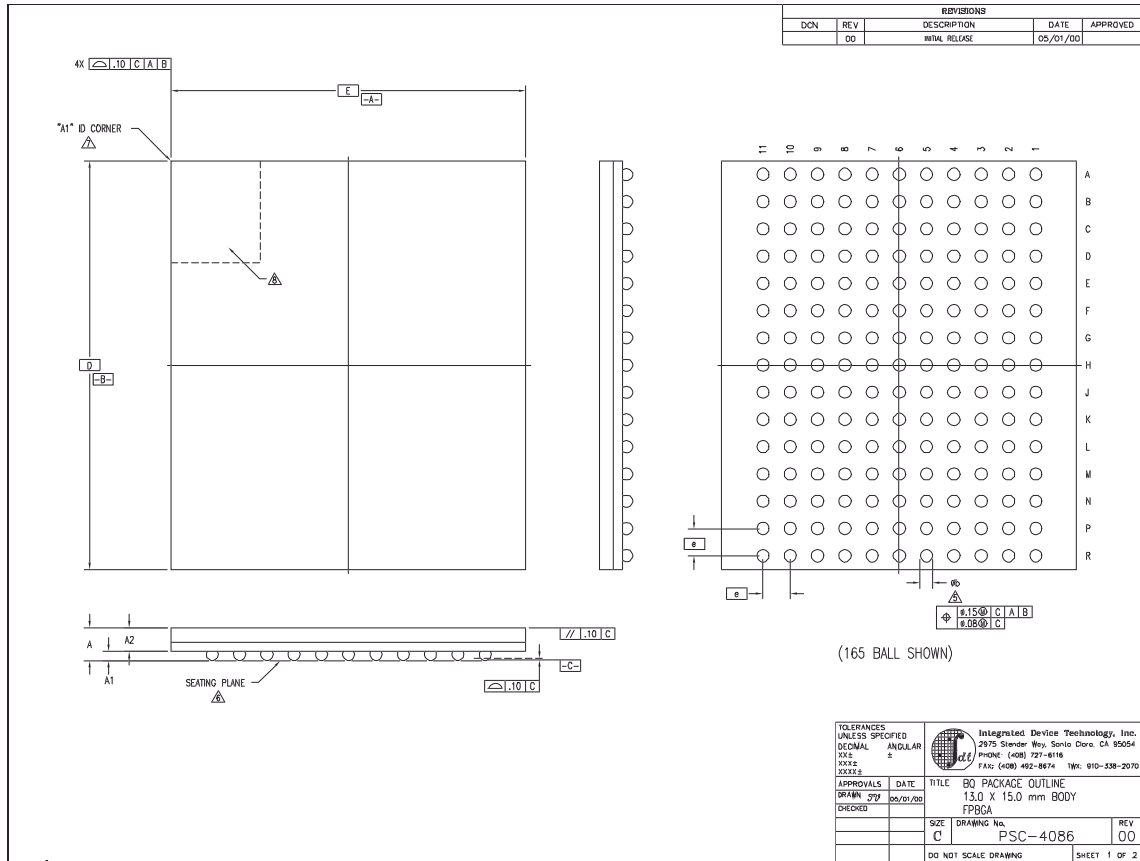
|    | MIN   | MAX   |
|----|-------|-------|
| P  | 22.80 | 23.00 |
| P1 | 19.80 | 20.00 |
| P2 | 18.85 | BSC   |
| Q  | 16.80 | 17.00 |
| Q1 | 13.80 | 14.00 |
| Q2 | 12.35 | BSC   |
| X  | .30   | .50   |
| e  | .65   | BSC   |
| N  | 100   |       |

|                                                                                     |                                                                                  |                                                                                                                                                                                                                                              |
|-------------------------------------------------------------------------------------|----------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TOLERANCES<br>UNLESS SPECIFIED<br>DECIMALS ANGULAR<br>Holes ±<br>Holes ±<br>Holes ± |                                                                                  |  <b>Integrated Device Technology, Inc.</b><br>3795 Shender Way, Santa Clara, CA 95051<br>PHONE: (408) 727-8818<br>FAX: (408) 482-8674 TBR: 916-330-1078 |
| APPROVALS / DATE<br>DRAWN<br>CHECKED                                                | TITLE<br><b>PK PACKAGE OUTLINE</b><br>14.0 x 20.0 x 1.4 mm TQFP<br>1.00/.10 FORM |                                                                                                                                                                                                                                              |
| SIZE<br><b>C</b>                                                                    | DRAWING No<br><b>P5C-4045</b>                                                    | REV<br>1                                                                                                                                                                                                                                     |
| DO NOT SCALE DRAWING                                                                |                                                                                  | SHEET 2 OF 2                                                                                                                                                                                                                                 |

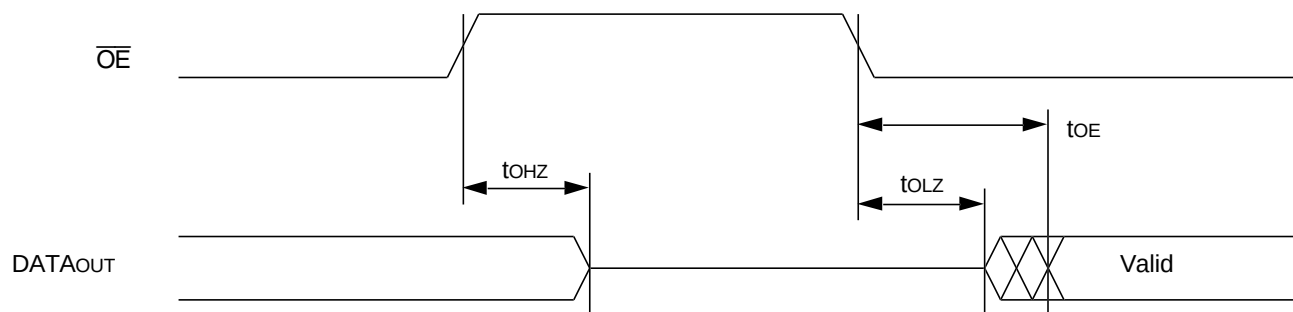
## 119 Ball Grid Array (BGA) Package Diagram Outline



# 165 Fine Pitch Ball Grid Array (fBGA) Package Diagram Outline



## Timing Waveform of $\overline{OE}$ Operation<sup>(1)</sup>

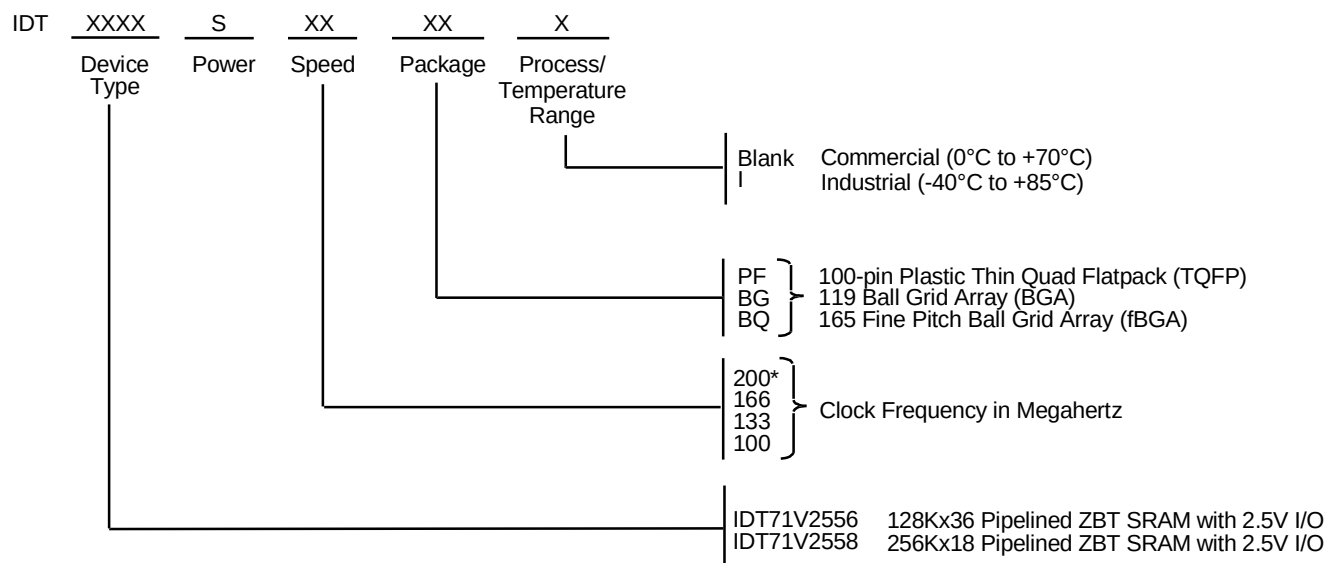


4875 drw 11

### NOTE:

1. A read operation is assumed to be in progress.

## Ordering Information



\*Available for commercial temperature range only.

4875 drw 12

## Datasheet Document History

|          |           |                                                                                                                               |
|----------|-----------|-------------------------------------------------------------------------------------------------------------------------------|
| 6/30/99  |           | Updated to new format                                                                                                         |
| 8/23/99  |           | Added Smart ZBT functionality                                                                                                 |
|          | Pp. 4, 5  | Added Note 4 and changed Pins 38, 42, and 43 to DNU                                                                           |
|          | Pg. 6     | Changed U2–U6 to DNU                                                                                                          |
|          | Pg. 14    | Added Smart ZBT AC Electrical Characteristics                                                                                 |
|          | Pg. 15    | Improved $t_{CD}$ and $t_{OE(MAX)}$ at 166MHz                                                                                 |
|          |           | Revised $t_{CHZ(MIN)}$ for $f \leq 133$ MHz                                                                                   |
|          |           | Revised $t_{OHZ(MAX)}$ for $f \leq 133$ MHz                                                                                   |
|          |           | Improved $t_{CH}$ , $t_{CL}$ for $f \leq 166$ MHz                                                                             |
|          |           | Improved setup times for 100–200 MHz                                                                                          |
|          | Pg. 22    | Added BGA package diagrams                                                                                                    |
|          | Pg. 24    | Added Datasheet Document History                                                                                              |
| 10/4/99  | Pg. 14    | Revised AC Electrical Characteristics table                                                                                   |
|          | Pg. 15    | Revised $t_{CHZ}$ to match $t_{CLZ}$ and $t_{CDC}$ at 133MHz and 100MHz                                                       |
| 12/31/99 |           | Removed Smart functionality                                                                                                   |
|          |           | Added Industrial Temperature range offerings at the 100 to 166MHz speed grades.                                               |
| 04/30/00 | Pg. 5,6   | Add clarification note to Recommended Temperature Ratings and Absolute Max Ratings table; Add note to TQFP Pin Configurations |
|          | Pg. 6     | Add BGA Capacitance table                                                                                                     |
|          | Pg. 7     | Add note to BGA Pin Configurations                                                                                            |
|          | Pg. 21    | Insert TQFP Package Diagram Outline                                                                                           |
| 05/26/00 |           | Add new package offering, 13 x 15mm 165fBGA                                                                                   |
|          | Pg. 23    | Correct 119 BGA Package Diagram Outline                                                                                       |
| 07/26/00 | Pg. 5,6,7 | Add zz, sleep mode reference note to TQFP, BG119 and BQ165 pinouts                                                            |
|          | Pg. 8     | Update BQ165 pinout                                                                                                           |
|          | Pg. 23    | Update BG119 package diagram outlines                                                                                         |
| 10/25/00 |           | Remove Preliminary Status                                                                                                     |
|          | Pg. 8     | Add note to pin N5, BQ165 pinout reserved for JTAG $\overline{TRST}$                                                          |



### CORPORATE HEADQUARTERS

2975 Stender Way  
Santa Clara, CA 95054

### for SALES:

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